Magnetic Levitation of Polymeric Photo-thermal Microgrippers

by

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Abstract

Precise manipulation of micro objects became great interest in engineering and science with the advancements in microengineering and microfabrication. In this thesis, a magnetically levitated microgripper is presented for microhandling tasks. The use of magnetic levitation for positioning reveals the problems associated with modeling of complex surface forces and the use of jointed parts or wires. The power required for the levitation of the microgripper is generated by an external drive unit that makes further minimization of the gripper possible. The gripper is made of a biocompatible material and can be activated remotely. These key features make the microgripper a great candidate for manipulation of micro components and biomanipulation.

In order to achieve magnetic levitation of microrobots, the magnetic field generated by the magnetic levitation setup is simulated. The magnetic flux density in the air gap region is improved by the integration of permanent magnets and an additional electromagnet to the magnetic loop assembly. The levitation performance is evaluated with millimeter size permanent magnets. An eddy current damping method is implemented and the levitation accuracy is doubled by reducing the positioning error to 20.3 µm.

For a MEMS-compatible microrobot design, the electrodeposition of Co-Ni-Mn-P magnetic thin films is demonstrated. Magnetic films are deposited on silicon substrate to form the magnetic portion of the microrobot. The electrodeposited films are extensively characterized. The relationship between the deposition parameters and structural properties is discussed leading to an understanding of the effect of deposition parameters on the magnetic properties. It is shown that both in-plane and out-of-plane magnetized films can be obtained using electrodeposition with slightly differentiated deposition parameters. The levitation of the electrodeposited magnetic samples shows a great promise toward the fabrication of levitating MEMS devices.

The end-effector tool of the levitating microrobot is selected as a microgripper that can achieve various manipulation operations such as pulling, pushing, tapping, grasping and repositioning. The microgripper is designed based on a bent-beam actuation technique. The motion of the gripper fingers is achieved by thermal expansion through laser heat absorption. This technique provided non-contact ac-
tuation for the levitating microgripper. The analytical model of the displacement of the bent-beam actuator is developed. Different designs of microgripper are fabricated and thoroughly characterized experimentally and numerically. The two microgripper designs that lead to the maximum gripper deflection are adapted for the levitating microrobot.

The experimental results show that the levitating microrobot can be positioned in a volume of $3 \times 3 \times 2 \text{ cm}^3$. The positioning error is measured as 34.3 $\mu$m and 13.2 $\mu$m when electrodeposited magnets and commercial permanent magnets are used, respectively. The gripper fingers are successfully operated on-the-fly by aligning a visible wavelength laser beam on the gripper. Micromanipulation of 100 $\mu$m diameter electrical wire, 125 $\mu$m diameter optical fiber and 1 mm diameter cable strip is demonstrated. The microgripper is also positioned in a closed chamber without sacrificing the positioning accuracy.
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Chapter 1

Introduction

In the past few decades, there is a tremendous rise in the number of multidisciplinary projects. The boundaries between disciplines is getting narrower, as researchers in different fields come up with fascinating ideas that combine knowledge in different areas. Such collaborations have opened new avenues especially in science and engineering where fundamental knowledge is applied in solving practical problems. This thesis presents such a multidisciplinary project where magnetic levitation is combined with micromanipulation to design and implement a magnetically levitated polymeric photo-thermal microgripper.

The advancements in the MicroElectroMechanical Systems (MEMS) in the past few years, made the implementation of micromanipulation systems possible. Researchers have developed various methods for engineering of micro systems to have more control on the micro domain. Micromanipulation enables positioning of micro objects with high precision. Applications of micromanipulation are numerous such as microassembly of micro components, manipulation of biological samples or single cells, microsurgery, modeling in microtribology and imaging of other micro/nano systems. When the accuracy required in these applications is considered together with the complexity of the dominant forces in micro domain, it can be seen that micromanipulation systems are facing significant hurdles. This thesis presents a new technology platform where micromanipulation is achieved using a non-contact actuated microgripper that is positioned in space using magnetic fields. Thanks to magnetic levitation, friction and adhesion forces are completely eliminated during the positioning of the microgripper. Dust-free operation, controllability in closed environments and remote actuation are the other key features of the magnetically
levitated microgripper presented in this dissertation.

1.1 Related Work

This thesis addresses various research challenges in different fields. In this section, a general overlook of magnetic levitation and micromanipulation is given. Detailed background information about problems addressed in each chapter is given at the beginning of the corresponding chapter to assist the reader.

1.1.1 Review of Magnetic Levitation

Magnetic levitation is a unique technology by which an object is suspended above the ground using magnetic fields. The basic principle of magnetic levitation is to balance the gravitational force with an equivalent electromagnetic force. The research and development in magnetic levitation was initiated in 1970’s for faster transportation technology. Germany, Japan and US were the leading countries investing in this new technology. The goal was to levitate trains on the rails to achieve higher speeds. The elimination of the friction between the rail and the trail led to considerable power savings and high speeds up to 581 km/h as reported in 2003 [1].

Besides non-contact manipulation, magnetic levitation offers dust-free operation as well. The long-reached jointed parts and any other moving mechanical components are eliminated. This ensures that no dust is generated during operation. Additionally, elimination of moving components resolves most of the maintenance problems associated with wearing and lubrication. Due to these unique features, magnetic levitation has been used in many other areas as well.

Magnetic levitation is used for teleoperated systems. In [2], using magnetically levitated aircraft models, the flight variables and aerodynamic variables were tested independently. Electromagnets were placed around the tunnel to adjust the magnetic field. The system has achieved lateral motion control for two orthogonal axis and rotational control around one axis. In [3], a teleoperation system was shown with a master and slave configuration. Six Lorentz actuators were positioned at 60° intervals around a horizontal base. The levitated master head eliminated static friction and could be moved in 6-DOF.
Bearings making use of magnetic levitation (magnetic bearings), eliminate the contact between the rotor and stator yielding higher rotation speeds. In [4], YBCO (Yttrium Barium Copper Oxide) based superconductor magnets were used for levitation. Displacement sensors were used for active position control. The sensors were tested in air and liquid nitrogen. It was seen that the use of superconductor magnets brings lots of practical complexities such as the cost and extra space for cooling system. 80 $\mu$m displacement was achieved in two axes. In [5], instead of a single large electromagnet, 24 tiny electromagnets were used for the rotor and the stator of the magnetic bearing. It was shown that the system could levitate 1.4 kg with this revised configuration.

Micropositioning stages benefit from magnetic levitation to provide ultra-precise positioning capabilities. These microstages are very promising because they overcome wearing, backlash and hysteresis observed in conventional systems. The wearing and backlash problems in conventional system mostly originate from the gear mechanisms, while hysteresis can be seen in piezoelectric actuators. In [6], a micropositioning stage with 5 nm resolution was shown. A triangular actuator assembly was used with electrostatic position sensors. The system could position a maximum payload of 1 kg with 6-DOF. In [7], ten electromagnets were used for a 6-DOF micropositioning stage. The position detection was implemented using laser interferometry. For a 1 mm travel motion range, the positioning error was measured as 10 nm.

Magnetic levitation is also promising in microelectronic fabrication. [8] succeeded in crystal growth of ionic crystals from a magnetically levitated melt. Two sets of electromagnets were used to levitate the melted aqueous solution suspended at 7.8 cm from the electromagnets. Using this method, the uncontrollable heterogeneous nucleation occurring due to container walls was suppressed. This led to improved crystal properties. In [9], magnetic suspension was used for silicon wafer transportation. Permanent magnets were used on the carrier to reduce the weight of the carrier stage. Electromagnets were placed on the base for stabilization of position. The propulsion force for transportation was obtained by using six coils patterned depending on the trajectory of motion.

These systems can achieve micrometer or even sub-micron resolution. However, the small air gap distance between the levitated object and the driving unit considerably limits the operating range. There is a need for a system which can magneti-
cally control objects at large distances. Khamesee et al. proposed a 3-DOF large gap magnetic levitation device with a traveling range of $29 \times 29 \times 26\, \text{mm}^3$ [10]. The levitated cylindrical robot was 50 mm in length and 12 mm in diameter. The robot accomplished precise pick-and-place tasks with millimeter size objects. However, there is still a need to further minimize the robot to access operation of micro-sized objects. If the robot can be successfully downsized, the large gap system can be used for operation in closed environments and inside human body, in addition to all the above mentioned applications. With the realization of a dexterous end-effector tool, such a system can be a breakthrough for biological tests and microsurgery where precision and clean operation are the main concerns.

### 1.1.2 Review of Micromanipulation

Micromanipulation is the movement of micro-scale or millimeter-scale objects from one position to another with micron or sub-micron accuracy. The currently available micromanipulation techniques can be listed as: atomic force microscopy (AFM), optical trapping and microrobotic stations. These techniques provide manipulation in different scales as shown in Figure 1.1.

AFM is a powerful technique that is principally used for imaging the surface...
morphology of samples with nanometer resolution. It was introduced by Binnig et al in 1986 [11]. Besides its use as a high sensitivity force sensing tool, AFM can be used for manipulation of objects. Atomic force microscope has a very sharp tip mounted at the end of a cantilever beam. While scanning the tip over the surface of the sample, the interaction between the sample and the tip is measured by monitoring the deflection of the beam. This sharp tip can be used to push micro objects as seen in [12]. However, use of AFM as a micromanipulation tool is very limited because of the high cost of the device. In addition, it is only used for pushing or rotating objects. Therefore, AFM is mostly being improved as an imaging or force sensing tool rather than a manipulation technique.

Optical trapping (or laser trapping) is another technique which was first introduced by Ashkin et al in 1985 [13]. When a laser beam is focused on a dielectric particle whose refractive index is higher than its surrounding medium, a polarizing force is applied to the particle. The direction of the force is always to the focal point of the laser. Then, by moving the focal point of the laser beam, the particles can be manipulated in a non-contact manner. The force resolution of optical trapping is sub-pN, therefore it is mostly used for gentle movement of single DNA molecule [14,15] or cells [16,17]. The main limitation of optical trapping is the low maximum force which is around a few pN. In addition, it can directly be used for manipulation of dielectric materials only. For manipulation of conductive or laser-sensitive objects, microbeads should be attached to the samples and these beads should be trapped by the laser which is a labor-intensive task [18].

The most common method of micromanipulation is using microrobotic stations. These stations are generally composed of a controllable motion stage, an end-effector tool and sensors for position, force or visual feedback. The design and implementation of these system are strongly influenced from the size, geometry, complexity of manipulated objects and the kind of task to be performed. The positioning of objects can be done by pulling, pushing, rotating, tilting, lifting or picking & placing of objects. The required action of manipulation sets the most important criteria when designing the end-effector tool.

There are numerous microrobotic manipulation tools in the literature. Due to their scientific and industrial uses, many research groups all around the world have implemented microrobotic stations. The microrobotic stations are usually classified according to the following system parameters:
• The degree of freedom
• Type of end-effector tool (needle, beam, probe, pipette, gripper, etc...)
• The operation principle (manual, tele-operated-automated)
• Resolution and speed
• Type of operation (serial, parallel, self-assembly)

There is vast amount of published data about micromanipulation and micro-robotics. The recent review articles by B. J. Nelson’s group [19, 20] and latest microrobotic systems [21–23] provide a nice overlook to the field. It can be seen that these microrobotic systems are usually custom-designed systems dedicated to a single application. Since the dominant forces in the microdomain are not completely understood and modeled, significant amount of energy is spent for developing advanced controller algorithms. The reliability of the end-effector tool and the repeatability of operation are other important questions that is not fully addressed due to the micro-scale operation range of the systems. Therefore, despite numerous available systems, there is still need for versatile micromanipulation systems that can be repeatedly used for multiple purposes that overcomes the hurdles of dominant surface forces in micro scale.

1.2 Problem Statement and Research Objectives

This thesis is presenting a new platform for precise manipulation of micro objects. The content of the thesis spans various disciplines. Therefore, many challenges in different research fields are addressed as schematically demonstrated in Figure 1.2.

As discussed in the previous section, for micromanipulation due to scaling laws body forces become less significant compared to surface forces. Since the manipulated objects are small, the end-effectors are designed as micro tools. The van der Waals forces, stiction, surface adhesion forces should be taken into account when aligning the end-effectors with the objects to be manipulated. To overcome all these forces, powerful driving mechanisms are required, which is very hard to achieve in micro-scale. Additionally, having the end-effector tool connected to a
meso-scale manipulator or controller limits the motion range and maneuverability of the end-effector because of the inconvenience of connection arms and wires. These problems can be completely eliminated if the end-effector is positioned using magnetic levitation. The levitated device does not get into contact with any surface and it is powered by an external system. This dissertation presents a novel system which positions the micro-scale end-effector tool by magnetic levitation. In order to levitate the end-effector tool, it should carry a magnetic material to interact with the external magnetic field generated by the levitation system. The levitation of the end-effector is achieved in two ways; attaching it to either commercial permanent magnets or electrodeposited magnetic films. In this way, the levitating portion of the microrobot is designed independently from the end-effector. The benefit of designing the magnetic section of the levitated object independently is that different end-effectors can be levitated without changing the manipulator setup that is designed based on the fixed magnetic section of the microrobot.

The next big question is choosing a dexterous end-effector. Comparing the available tools such as microprobes, needles, pipettes, beams, grippers, it is seen that microgrippers can be used for multiple tasks. A microgripper can achieve not only the simple operations of pulling, pushing, rotating, tilting but it can also be used for relatively complicated pick-and-place operations. Manipulation using microgrippers resembles operation of human fingers. This explains the higher accuracy that can be achieved by microgrippers compared to other end-effector tools.

When the use of microgrippers is considered, it is seen that low-cost, safe handling and biocompatibility are important constraints, specifically for biomanipulation applications. This problem is addressed by fabricating the grippers from a biocompatible polymeric material (SU-8) that achieves gentle grasping.

Having the passive polymeric microgrippers attached to magnetic objects and levitated, actuation of the microgripper still remains a big challenge. Conventional techniques of electrothermal, electrostatic, pneumatic actuation can not be used because the levitating grippers require a non-contact actuation mechanism. Magnetic actuation can not be applied since high magnetic fields are used to levitate and position the objects. This problem is resolved by applying non-contact photo-thermal actuation. Photo-thermal actuation combined with the use of polymeric materials allowed repeatable and high displacement gripper finger operation that makes the
manipulation of objects with various sizes possible as demonstrated in this dissertation. The combination of magnetic levitation with polymeric microgripper and photo-thermal actuation led us to the design and implementation of “magnetically levitated polymeric photo-thermal microgripper”. This micromanipulation system not only addressed the above mentioned problems, but also offers unique features such as dust-free operation and operation in closed environments.

### 1.3 Outline

The goal of this project is to design and implement a magnetically levitated polymeric photo-thermal microgripper that is capable of manipulating micro objects. The dissertation is divided into five main parts: introduction, levitation of permanent magnets, levitation of electrodeposited thin films, design, fabrication and characterization of polymeric photo-thermal microgrippers and levitation of microgrippers. Background information and related work are presented at the beginning of each corresponding chapter.

**Chapter 1** introduces the idea of micromanipulation using magnetic levitation. A review of magnetic levitation and micromanipulation is given. The objectives of the dissertation are presented.

**Chapter 2** explains the experimental setup used for magnetic levitation. Indi-
individual components of the setup are explained in detail. Theory of magnetic levitation is discussed. Experiments are performed with permanent magnets of different sizes. Eddy current damping is implemented to improve the levitation accuracy.

Chapter 3 explains the magnetic levitation of electrodeposited magnetic thin film samples. First, an overview of atomic magnetization and magnetic material deposition techniques is given. Fabrication of the magnetic thin films is presented followed by the in-depth structural and magnetic characterization of the films. Experimental results of levitating deposited magnetic films are presented.

Chapter 4 addresses the design and modeling of photo-thermal microgripper. An analytical model of photo-thermal bent-beam actuator is presented. Using the photo-thermal bent-beam actuator, different microgrippers are designed. Each microgripper design is simulated to verify the operation of the gripper fingers. The microgrippers are fabricated using conventional photo-lithography. Through the experiments of microgrippers, the analytical model is verified and microgrippers are characterized in detail.

Chapter 5 combines the results of the previous chapters to demonstrate micromanipulation using magnetically levitated photo-thermal microgripper. Various microrobot configurations are presented. Both permanent magnets and electrodeposited magnets are used for the levitation. The performance of the levitated microrobots is evaluated for one-dimensional (1D) and three-dimensional (3D) trajectories. Successful manipulation of micro objects is presented as well as the manipulation of the microrobot in a closed chamber.

Chapter 6 summarizes the contributions of this study. Some potential directions are suggested as future work.
Chapter 2

Magnetic Levitation of Permanent Magnets

In this chapter, the magnetic levitation system is explained in detail. Section 2.1 presents the background and related work about magnetic levitation. Section 2.2 explains the components of the magnetic levitation setup. Section 2.3 describes the magnetic levitation theory and the controller of the levitation setup. Section 2.4 presents the experimental results of magnetic levitation of various sizes of permanent magnets. In Section 2.5 an eddy current damping mechanism is introduced and positioning precision is discussed.

2.1 Background and Related Work

Magnetic levitation is a widely known phenomenon today. However, in 1842 Samuel Earnshaw proved that it is not possible to achieve stable levitation using any combination of fixed magnets and electrical charges. For stable levitation, the net force acting on the body should be zero. The static force acting on a body due to gravitation, electrostatic and magnetic fields is always divergenceless, $\nabla \cdot F = 0$. If an object is levitated at a point in space, the net force must point to that equilibrium point on a surface encircling the point, i.e. $\oint_S F \cdot dS \neq 0$. However, using divergence theorem,

$$\oint_S F \cdot dS = \int_V \nabla \cdot F \, dV = \int_V 0 \, dV = 0$$

(2.1)
it can be shown that the closed surface integral results in zero which contradicts with nonzero net force statement. Interestingly, this result forbids static levitation as stated by Earnshaw’s theorem.

The electromagnetic suspension levitation systems get around this theorem by continuously varying the magnetic field that compensates the gravitation force. Although the levitated objects are constantly oscillating around the equilibrium point, it looks like a flawless levitation since the resolution of human eye is only 200 μm.

Therefore in electromagnetic suspension systems, the levitation force is increased when the object drops below the desired point and increased again if it passes over the point (Figure 2.1). As long as these deflections are kept below 200 μm, the vibrations can not be perceived by human eye. Obviously, for a real micro-manipulation application, the deflections should be further decreased. A magnetic levitation set-up realized by Khamesee et al, in 2002 Japan, has proven to be very successful in this [10]. A positioning precision of 50 μm was reported. The system can magnetically control the robot shown in Figure 2.2 in 3D to perform pick-and-place tasks. The robot is 50 mm in length and 12 mm in diameter and consists of a magnetic head, a body frame and fingers. The magnetic head is formed by cross assembly of permanent magnets that supply the required energy for levitation. The gravitational force of the robot is balanced by the levitation force generated by these magnets. Using commercial rare earth permanent magnets a force of 0.088
N was generated and levitation of the robot with a net mass of 8.1 g was accomplished. The body of the device carries the electronic circuitry and the batteries. A circuit with a photo-IC was designed for switching the gripping mechanism. The fingers are made of copper alloy and they are connected with a shape memory alloy (SMA) actuator that enabled the gripping action when a current is passed through. Although this system is capable of manipulating cm-sized objects, due to the size of the robot (Figure 2.2), it can not be used for micromanipulation.

In the literature, there are only a few studies that report levitation in microscale. Iizuka and Fujita levitated a cylindrical slider with 3 mm diameter and 1.1 mm thickness [24]. They have used YBCO (Yttrium Barium Copper Oxide) superconductors for magnetic levitation. The motion range was limited with the size of the superconductor disk which had a diameter of 25 mm. They obtained 40 µm accuracy but the air gap was only 1 mm which restricts the applicability of the system. In 2002, Morita et al introduced a microlevitation system that levitated a small iron ball of 2 mm diameter [25]. The system balanced the weight of the ball by utilizing motion control of the levitation unit which carried a SmCo (Samarium Cobalt) permanent magnet. The distance between the levitated object and the assembled permanent magnet was adjusted continuously to balance the weight of the object with the attractive magnetic force. The magnetic levitation of the ball in 1-DOF was achieved, but with high vibrations. Also, the motion range and air gap were 40 µm only, since they were limited with the stroke of the piezoelectric actuator. Although these systems can levitate tiny objects, they suffer from very low gap distances which limit their applicability. In addition, the challenge of integrating a micromanipulator tool to the levitated object and actuation of this tool is not addressed by these studies [24, 25]. Therefore, the magnetic levitation
system presented in this study is unique in terms of the large motion range, precision achieved, size of the levitated object and the actuation principle.

2.2 Experimental Setup

The mechanical assembly of the magnetic levitation setup was mainly designed and implemented by E. Shameli [26] and D. Craig [27]. A brief description of the levitation setup is presented in this section. For a more detailed description about the determination of mechanical parameters and controller design, the interested readers can refer to [26,27].

The magnetic levitation setup consists of a real-time (RT) controller (National Instruments - NI PXI-8186), a host computer, three CCD laser line displacement sensors (Keyence LS-5041), a custom-design iron yoke and seven electromagnets connected with a pole piece. A schematic drawing of the levitation system and a picture of the setup without the controller are shown in Figure 2.3 and Figure 2.4, respectively.

The body of the device is made of iron to complete the magnetic circuit and to preserve high magnetic field in the large air gap which is around 29 cm. The magnetic flux generated by the electromagnets can loop along the iron yoke so that large magnetic fields can be obtained. The dimensions of the yoke are determined...
based on the magnetic saturation limit of iron and the leakage flux from the air gap opening. The yoke has a square cross section with a side length of 6.35 cm. The height of the yoke can be adjusted between 65 cm and 80 cm. These dimensions ensured that the system has enough structural stiffness as a stand-alone setup and also it can carry the magnetic flux generated by the electromagnets without saturation [26].

The electromagnets are placed at the upper end of the yoke. Each electromagnet has a magnetomotive force of 1543 Ampere-turns with 750 turns of wire and a current limit of slightly greater than 2 A. The limiting factor on the magnetomotive force is the maximum current that can be applied to the electromagnets due to the excessive heating. The electromagnets are positioned very close to each other and no cooling system is used. Therefore high currents cause considerable heat that cannot be dissipated and affect the magnetization properties of the iron yoke. Therefore, the system parameters are changed and stability is lost when current levels exceed 2 A. In order to achieve 3-dimensional (3D) position control, the magnetic field should be adjusted in the 3D space below the electromagnets. For that purpose, multiple electromagnets are used. The currents applied to the electromagnets can be individually controlled that allows the precise adjustment of the magnetic field in 3D. The seven electromagnets are connected with a circular soft iron pole piece and positioned as shown in Figure 2.5. The pole piece has a diameter of 13.2 cm and a thickness of 0.635 cm. The finite element simulations shown in Section 2.3 demonstrate that the configuration demonstrated in Figure 2.5
can control the magnetic field both horizontally and vertically, therefore allows 3D magnetic levitation.

The laser sensors are placed on a stand connected to the yoke. The stand height can be adjusted to change the working range of the microrobot. Three sets of laser sensors are used to detect the position in 3D. Each set consists of a laser transmitter and receiver with a measuring range of 0.2 - 40 mm. The laser sensors have a maximum resolution of 2 - 8 \( \mu \text{m} \) which varies depending on the position range as shown in Figure 2.6 [26]. The lasers has an analog output range of +/- 10 V with 5 mV resolution.

The NI PXI-816 real-time controller communicates to the laser position sensors and the electromagnets through 16-bit A/D and 16-bit D/A converters, respectively. The position sensors provide the position feedback to the controller and the currents applied to the electromagnets are adjusted accordingly to control the magnetic field in the air gap. The control power is provided by 40 V voltage supplies (Sorensen DCS40-30E) amplified by a custom–design power amplifier. The power amplifier provides current according to its input voltage that is determined by the controller. Each electromagnet is connected to a channel of the amplifier and the gain of the amplifier is experimentally determined as

\[
I = 0.355 \text{ V}  \quad (2.2)
\]

NI LabVIEW RT 8.0 and NI LabVIEW 8.0 software are used for the real-time controller and the host computer respectively. The two systems communicate with
a TCP/IP connection. LabVIEW facilitates the implementation of the controller by providing a graphical-based programming environment. The LabVIEW RT 8.0 is run on the controller and provides a real-time deterministic control while the user interface is provided on the host computer for parameter changes. A sample user interface screen is given in Figure 2.7. LabVIEW pre-defined functions allow the measured position data from the three laser sensors to be saved as a single file (in CSV format). The position of the levitating object can be plotted from this CSV file using Matlab.

As seen in Figure 2.7, the user can change the position of the levitating object using the input text boxes provided by LabVIEW. Although fixed trajectories can be defined for the levitating object, in most cases the operator inputs are required for fine adjustments during levitation experiments. In order to further facilitate the operation of the system, a cordless USB keypad (Logitech) is implemented. Although it is a straightforward task to write keyboard listening codes for LabVIEW, it is a tedious task for the real-time controller to listen for keyboard interruptions during real-time operation. Any interruption for the real-time controller introduces a delay to the high-priority controller loop and causes instability of the levitating object. This problem is addressed by the “shared variable” feature introduced in LabVIEW 8.0. Similar to “global variables” which can exchange values between different portions of the code in a single project, “shared variables” can exchange
values over the TCP/IP connection during real-time operation. Defining the desired position inputs as shared variables, the keyboard listening routine is run by the host computer and the entered values are transferred to the real-time controller through the shared variables.

A picture of the cordless keypad is given in Figure 2.8. The keypad allows the position control of the levitating object using the “arrow” keys defined for x, y and z directions. The speed of the levitating robot can also be controlled by changing the step length for the arrow keys using “fine” and “coarse” keys. Some additional features are also defined for the operator that increases the control of the operator during the experiments. For instance, three keys are reserved for setpoint defining (keys “A”, “B” and “C”). The instantaneous position of the levitating microrobot can be saved as a setpoint by pressing one of these keys. When it is required for the robot to get back to this point, the user just presses “GoTo” and the corresponding setpoint (“A”, “B” and “C”) simultaneously. The type of motion can also be changed from step motion to ramp motion.

Another add-on feature included to the levitation system is the high resolution long working distance camera. Apart from the levitation and control of the microrobots, monitoring the microrobot and its environment is also quite challenging.
due to the high magnification required. The presence of high magnetic fields makes it difficult to position a camera close to the objects. Therefore there is a need for a vision system with a high resolution camera and a lens system with large depth-of-field and long working distance. A 5-Megapixel Prosilica GC2450 camera is used together with 5-pieces Schneider lenses as shown in Figure 2.9. This system provides a $2 \mu m$/pixel resolution for a $9 \times 11 \text{ mm}^2$ field-of-view at approximately 12 cm. The performance of the vision system can be seen in Figure 2.9 when it is focused to a coin at a distance of 12 cm. The camera provides black/white images at a rate of 15 fps. Each frame taken by the camera is around 4.2 Mb which requires a data transfer of 60 Mb/sec during recording. This massive data transfer rate is handled by using two 10,000 rpm hard-drives in parallel configuration that are configured by the Streampix software.
2.3 Principle of Magnetic Levitation

It is important to have an understanding of magnetic levitation before discussing 3D motion control during levitation. Magnetic levitation is achieved with the interaction of an external magnetic field with a magnetic body. If a magnetic object is subjected to an external magnetic field, the magnetic coupling arises an energy called Zeeman energy. If the object has a volume magnetization of $M$ and the external field is represented by $H$, Zeeman energy can be calculated as

$$E_z = -\mu_0 \int_V M.H \, dV,$$

where $\mu_0$ is the absolute permeability. If the object is uniformly magnetized, the dipole moment of the object can be found by multiplying the magnetization with volume as

$$m = V.M.$$
Substituting Eq. 2.4 into Eq. 2.3, Zeeman energy can be expressed as

\[ E_z = -\mu_0 \int_V \left( \frac{m}{V} \cdot H \right) dV. \]  

(2.5)

For very small objects as in this thesis, it can be assumed that the applied field, \( H \), is constant throughout the volume of the object. Then Zeeman energy in free space can be simplified to

\[ E_z = -\mu_0 \left( \frac{m}{V} \cdot H \right) V = -\mu_0 m.H = -m.B, \]  

(2.6)

where \( B \) denotes magnetic flux density. Virtual displacement method allows calculation of force if the corresponding energy is known. Using this principle, the magnetic force, \( i.e. \) the levitation force, can be found as

\[ F_{lev} = -\nabla E_z = -\nabla (-m.B) = \nabla (m.B). \]  

(2.7)

In cartesian coordinate system, the levitation force can be written as

\[ F_{lev} = \hat{x} \frac{\partial}{\partial x} (m.B) + \hat{y} \frac{\partial}{\partial y} (m.B) + \hat{z} \frac{\partial}{\partial z} (m.B). \]  

(2.8)

Eq. 2.8 demonstrates that to have a force in a certain direction the magnetic flux density, \( B \), should be nonuniform along that direction. The object moves along the increasing field direction and comes to an equilibrium at the maximum field point, \( B_{max} \). This is an important criterion for the design of the electromagnet configuration and pole piece shape explained in Section 2.2. Khamesee and Shameli have shown that a circular pole piece can generate a single \( B_{max} \) point in space [29]. In addition, they have demonstrated that by varying the ratios of current applied to the electromagnets, it is possible to move the \( B_{max} \) point on the horizontal plane. In this way, 3D motion of the levitated object can be achieved. The total current of the electromagnets determine the vertical position while the ratio of the electromagnets placed across the center vary the horizontal location.

For a better understanding of horizontal motion, some horizontal positioning simulations are shown in this section. These simulations demonstrate the horizontal motion capability of the magnetic levitation system. The electromagnets are positioned as demonstrated in Figure 2.5. To move the levitating robot on the horizontal plane, the position of the maximum flux density point, \( B_{max} \), should be changed. The precise manipulation of the \( B_{max} \) point can be shown by finite
Figure 2.10: 3D drawing of magnetic levitation setup in ANSYS.

element simulations. A 3D solid body of the levitation system was drawn by ANSYS as seen in Figure 2.10. When equal currents of 1.5 A was applied to the electromagnets, the magnetic field strength on the horizontal plane 8 cm below the electromagnets was simulated as shown in Figure 2.11. The magnetic flux density was shown on the left as surface plots together with the contour plots on the right. To move the $B_{\text{max}}$ point in x direction, the current applied to electromagnets 1 and 4 was increased to 2 A, while the current applied to electromagnets 3 and 6 was reduced to 1 A. Figure 2.11(b) shows that $B_{\text{max}}$ shifted in x direction by 2.1 cm. Similarly, the $B_{\text{max}}$ point is moved in y direction by increasing the currents of electromagnets 1-2-3 to 2 A and reducing the currents of electromagnets 4-5-6 to 1 A (Figure 2.11(c)). The nonsymmetric positioning of the electromagnets for x and y directions should be kept in mind for horizontal position control. To move the levitated objects in x direction, current of four electromagnets are changed, whereas for a motion along y direction, currents of six electromagnets are varied.

The levitation system uses a PID closed-loop controller for the vertical levitation and an open loop controller for horizontal position control. For the vertical position control, the position of the levitated object is continuously detected by the laser
Figure 2.11: Simulated magnetic flux density on horizontal plane: (a) Same current is applied to all electromagnets, (b) More current is applied to electromagnets in -x direction, (c) More current is applied to electromagnets in +y direction.
sensor and is sampled by the A/D converter. Based on the position data, the position error, change in the position and position integral error are calculated. Multiplying these values with controller gains, the control current that needs to be applied to the electromagnets is determined. If the object is moved vertically along the symmetry axis of the air gap, this current is applied to all of the electromagnets. When horizontal motion is required, the amount of current is increased for the electromagnets in the desired direction of motion, while keeping the summation of currents constant. The governing equations for the horizontal motion were derived by D. Craig as [27]

\[
\begin{align*}
I_1 &= I(1 + x_{ctrl})(1 + y_{ctrl}) \\
I_3 &= I(1 - x_{ctrl})(1 + y_{ctrl}) \\
I_4 &= I(1 + x_{ctrl})(1 - y_{ctrl}) \\
I_6 &= I(1 - x_{ctrl})(1 - y_{ctrl}) \\
I_2 &= \frac{(6I - I_1 - I_3 - I_4 - I_6)(1 + 1.25 y_{ctrl})}{2} \\
I_5 &= \frac{(6I - I_1 - I_3 - I_4 - I_6)(1 - 1.25 y_{ctrl})}{2} \\
I_7 &= I
\end{align*}
\] (2.9) - (2.15)

where \( x_{ctrl} \) and \( y_{ctrl} \) are the current ratio factors changed by the operator commands and \( I_i \) is the current applied to the \( i \)'th electromagnet. Depending on the measurement range of the laser sensors, the range of \( x_{ctrl} \) and \( y_{ctrl} \) were determined as following using ANSYS simulations.

\[
-1.8 \leq x_{ctrl} \leq 1.8 \quad (2.16)
\]
\[
-1.8 \leq y_{ctrl} \leq 1.8 \quad (2.17)
\]

It can be seen that when \( x_{ctrl} = y_{ctrl} = 0 \), the same current is applied to the electromagnets and the robot is aligned with central axis of air gap.

The PID controller for the vertical levitation was designed by a state feedback controller design approach. For 1-DOF levitation, the governing equation of motion can be written as

\[
m \frac{d^2 z}{dt^2} = F_{lev} - mg, \quad (2.18)
\]

where \( m \) is the mass of the levitated object, \( g \) is the gravitational acceleration and \( F_{lev} \) is the \( \dot{z} \) component of the levitation force applied by the magnetic drive.
unit. For an object that has a net dipole moment of $m$ in $z$ direction, the vertical levitation force can be expressed as

$$F_{\text{lev}} = m \frac{\partial B_z}{\partial z},$$

(2.19)

where $B_z$ is the vertical magnetic flux density generated by levitation system. Due to the effect of yoke and pole piece, obtaining a formula for magnetic flux density generated by the system is very challenging. Shameli et al has followed an experimental method to derive a formula for the levitation force to be [30]

$$F_{\text{lev}} = \alpha I_z + \beta I,$$

(2.20)

where $\alpha$ and $\beta$ are fitting constants, $I$ is the current applied to the electromagnets and $z$ is the distance between the object and the pole piece. Substituting Eq. (2.20) into (2.18), the differential equation of the system is derived as

$$m \frac{d^2 z}{dt^2} = \alpha I_z + \beta I - mg.$$

(2.21)

The state variables are chosen as position error ($x_1 = z - z_c$), velocity ($x_2 = \frac{dz}{dt}$) and integral position error ($x_3 = \int (z - z_c) dt$) of the levitating object, where $z_c$ is the position command. Defining the input of the system as the current ($I$) applied to the electromagnets, state equations of the system can be obtained as

$$\frac{dx_1}{dt} = \Phi_1 = x_2,$$

(2.22)

$$\frac{dx_2}{dt} = \Phi_2 = \frac{\alpha}{m} I x_1 + \frac{\beta}{m} I - g$$

(2.23)

$$\frac{dx_3}{dt} = \Phi_3 = x_1.$$  

(2.24)

By linearizing the system around multiple working points ($I_0, z_0$) using Lagrange’s method, the state matrices can be found as

$$A = \begin{bmatrix} \frac{\partial \Phi_1}{\partial x_1} & \frac{\partial \Phi_1}{\partial x_2} & \frac{\partial \Phi_1}{\partial x_3} \\ \frac{\partial \Phi_2}{\partial x_1} & \frac{\partial \Phi_2}{\partial x_2} & \frac{\partial \Phi_2}{\partial x_3} \\ \frac{\partial \Phi_3}{\partial x_1} & \frac{\partial \Phi_3}{\partial x_2} & \frac{\partial \Phi_3}{\partial x_3} \end{bmatrix}_{z_0, I_0} = \begin{bmatrix} 0 & 1 & 0 \\ \frac{\alpha}{m} I_0 & 0 & 0 \\ 1 & 0 & 0 \end{bmatrix}$$

(2.25)

$$B = \begin{bmatrix} \frac{\partial \Phi_1}{\partial U} \\ \frac{\partial \Phi_2}{\partial U} \\ \frac{\partial \Phi_3}{\partial U} \end{bmatrix}_{z_0, I_0} = \begin{bmatrix} 0 \\ \frac{\alpha}{m} z_0 + \frac{\beta}{m} \\ 0 \end{bmatrix}$$

(2.26)

$$X = \begin{bmatrix} x_1 \\ x_2 \\ x_3 \end{bmatrix}, \quad U = I, \quad \frac{dX}{dt} = AX + BU.$$  

(2.27)
Then, the control current \( I \) can be determined as

\[
I = I_0 - [K_1 x_1 + K_2 x_2 + K_3 x_3],
\]

where \( K_1, K_2, K_3 \) are the feedback gains determined by pole placement. For the levitation experiments shown in the following section, the feedback gains are selected as 130, 100 and 4 respectively.

\[ 2.28 \]

### 2.4 Levitation of Permanent Magnets

In order to investigate the performance of the levitation system, various experiments were performed with commercially available cylindrical neodymium iron boron (NdFeB) permanent magnets. The experiments were carried with different sizes of magnets. The size of the levitated object was decreased gradually. The weights and the dimensions of the magnets are summarized in Table 2.1. Step inputs were applied to the system as reference for the levitated object to follow (shown as dashed line in Figure 2.12).

<table>
<thead>
<tr>
<th></th>
<th>(a)</th>
<th>(b)</th>
<th>(c)</th>
<th>(d)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Magnet weight (mg)</td>
<td>5950</td>
<td>757</td>
<td>386</td>
<td>140</td>
</tr>
<tr>
<td>Radius × thickness (mm)</td>
<td>5×10</td>
<td>2.5×5</td>
<td>2.5×2.5</td>
<td>2×1.5</td>
</tr>
<tr>
<td>Rms error for z=-0.084 m (μm)</td>
<td>22.58</td>
<td>32.75</td>
<td>55.90</td>
<td>50.42</td>
</tr>
<tr>
<td>Rms error for z=-0.083 m (μm)</td>
<td>19.07</td>
<td>43.55</td>
<td>78.25</td>
<td>134.77</td>
</tr>
<tr>
<td>Average rms error (μm)</td>
<td>20.83</td>
<td>38.15</td>
<td>67.08</td>
<td>92.60</td>
</tr>
</tbody>
</table>

The experimental results are illustrated in Figure 2.12. It is observed that when levitated object size is decreased, less precision is obtained. The rms position errors for each experiment are also shown in Table 2.1. The overshoot due to the step input and noise cause smaller objects to experience higher vibrations around the reference position. The average position error is 20.83 μm for the largest magnet.

---

\[ ^1 \] Rms error is calculated starting from the second crossing of the position data with the reference input, so the first overshoot is not taken into account.
while it is 92.60 µm for the smallest one. Therefore, the levitation of small objects suffers from the low environment stiffness and requires a damping mechanism.

The drastic increase in the positioning error for small objects might be because of the increasing effect of noise on a smaller object. Due to the scaling laws, the electrostatic force becomes dominant in micro scale, while gravitational force loses significance. Therefore, electrostatic noise in the environment is more effective on a smaller object. Also, any inherent noise of the system, which can be caused by measurement noise and conversion errors is more disturbing for a smaller object. In addition, air drag force, which is neglected in the dynamic equation of motion in the controller design, is more significant for a smaller object. The air drag force is scaled down by two (proportional to surface area) while the mass of the system is scaled by three (proportional to volume) resulting in a larger acceleration due to $a = F/m$. All these factors contribute to the larger deflection in the positioning of small objects.
2.5 Eddy Current Damping

The levitation experiments revealed that an additional mechanism is required to suppress the oscillations for microlevitation. Especially for levitation of microscale objects, a damping mechanism is highly required to improve the positioning accuracy.

An eddy current damping mechanism was proposed because of its ease of employment and non-contact operation. In addition, eddy current damping does not require a change in the controller algorithm or does not increase the cost or complexity of the system.

In this section, magnetic damping is presented that forms the guidelines of optimum eddy current damper design for microlevitation systems. A quantitative analysis is presented in Appendix A.

Eddy current damping was applied to the system by placing non-ferromagnetic (aluminum) plates underneath the levitated object. Since levitated objects were cylindrical, disc-shaped plates were used that simplifies the analytical calculation of flux passing through the plate in a great extent. A 6061-Al disc was placed on a glass stand, below the working domain of the magnet.

During the oscillations of the levitated object, a changing magnetic field is generated in the gap region. The time-varying magnetic field has two sources: 1- The change of the field generated by the electromagnets (when position of the object changes, the controller adjusts the currents supplied to the electromagnets). 2- The self magnetic field of the moving permanent magnet. If a conductor is placed in the varying field, circulating eddy currents are formed. The direction of the current is such that, magnetic field generated by this eddy current opposes the change in the field itself. Consequently, the conductor serves as a damper to the levitating magnet.

Experimental results of Section 2.4 present that small objects have an oscillatory motion of levitation. Therefore, the magnetic flux in the vicinity of the object oscillates, as well.

Appendix A gives the detailed derivation of the damping coefficient for oscillat-
ing permanent magnets. The damping coefficient was calculated as

\[ c = \frac{d\pi\sigma\Phi_1^2}{8h^2} \quad \text{and} \quad \Phi_1 = \frac{\mu_0}{2}m \left[ \frac{r^2}{(r^2 + (z' - h)^2)^{3/2}} - \frac{r^2}{(r^2 + z'^2)^{3/2}} \right] + \Delta\Phi_{em} \hspace{1cm} (2.29) \]

where

- \( d \) = disc thickness
- \( \sigma \) = conductivity of plate
- \( h \) = the maximum deflection during oscillation
- \( m \) = dipole moment of the magnet
- \( r \) = disc radius
- \( z' \) = disc-object distance

\( \Delta\Phi_{em} \) = Change in the flux density generated by electromagnets due to the oscillatory motion of the magnet.

The damping effect is plotted as a function of disc radius, \( r \), and disc-object distance, \( z' \), in Figure 2.13. It is seen that there is a critical disc radius which maximizes the damping effect for each disc-object distance. This behavior stems from the fact that magnetic flux lines of levitated permanent magnet forms a loop from its north pole to its south pole. When the radius of the disc is increased, the returning flux lines are also encircled by the plate which cancels the net magnetic field change.

The proposed damping mechanism was applied to the levitation of the magnet with 2.5 mm radius and 2.5 mm height. In Section 2.4, it was demonstrated that, this magnet wobbles during levitation with an rms error of 67.08 \( \mu m \). To observe the effect of eddy current, levitation of the same magnet was carried out with eddy current damping. Three Al-6061 discs were prepared with different radii and thicknesses as specified in Table 2.2. The same reference input was given to the system while the discs were placed as dampers. For all experiments, the discs were kept at \( z = -0.090 \) m that resulted in a disc-object distance of 7 mm maximum.

For comparison, the experimental results without damping and with different dampers are illustrated in Figure 2.14. The experiments confirm that eddy current damping is very effective to suppress vibrations. The positioning error was reduced
Figure 2.13: The effect of disc radius & disc-object distance on damping coefficient. $h = 0.2$ mm [28].

<table>
<thead>
<tr>
<th>Figure 2.14</th>
<th>(b)</th>
<th>(c)</th>
<th>(d)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Plate radius × thickness (mm)</td>
<td>19×4.5</td>
<td>19×9</td>
<td>51×9</td>
</tr>
<tr>
<td>Rms error for $z=-0.084$ m ($\mu$m)</td>
<td>42.69</td>
<td>22.10</td>
<td>20.16</td>
</tr>
<tr>
<td>Rms error for $z=-0.083$ m ($\mu$m)</td>
<td>45.89</td>
<td>22.72</td>
<td>20.44</td>
</tr>
<tr>
<td>Average rms error ($\mu$m)</td>
<td>44.29</td>
<td>22.41</td>
<td>20.30</td>
</tr>
</tbody>
</table>

from 67.08 $\mu$m to 20.30 $\mu$m. Even the smallest disc (19×4.5 mm) improved the levitation performance significantly (Figure 2.14(b)). It was observed that as the disc thickness was increased, higher precision was achieved (Figure 2.14(c)). In addition, as Eq. 2.30 implies, increasing the disc radius from 19 mm to 51 mm did not result in a significant change in precision. The rms error decreased from 22.41 $\mu$m to 20.30 $\mu$m (Figure 2.14(c) and (d)) due to the behavior plotted in Figure 2.13. Using a two-step input trajectory during the experiments allowed to observe the effect of disc-object distance on damping, as well. The disc was located at $z = -0.090$ m. When the object was levitated from -0.084 to -0.083 m, the disc distance increased from 6 mm to 7 mm. The rms position errors for each height were calculated separately. Although, it is hard to observe the difference
Figure 2.14: Step responses of 2.5×2.5 mm magnet with/without eddy current dampers: (a) no damper, (b) 19×4.5 mm disc, (c) 19×9 mm disc, (d) 51×9 mm disc [28].

from Figure 2.14, Table 2.2 indicates the slight increase in error for $z = -0.083$ m compared to $z = -0.084$ m. Therefore, the damping effect decreases and larger vibrations are observed when disc-object distance increases.
Chapter 3

Magnetic Levitation of Electrodeposited Thin Films

In this chapter, the development of magnetic thin films is presented. These films form the body of the levitated microrobot and interacts with the external magnetic field to generate the levitation force. A basic theory of magnetism is presented in Section 3.1. In Section 3.2 the electrochemical deposition of thin film magnets is discussed. The characterization of the films are done by scanning electron microscopy, energy dispersive x-ray spectroscopy, x-ray diffraction and magnetic property measurement system as demonstrated in Section 3.3. The relationship between the deposition parameters and the resultant films are determined based on the theoretical and experimental results. In Section 3.4 magnetic levitation of these films is presented.

3.1 Background and Related Work

Thin film hard magnet deposition is of high interest to researchers in the last few decades. Thin film hard magnets are mainly used for magnetic recording media and bidirectional micro-actuation. Producing more powerful magnets is the ultimate aim of these studies.

The magnetic properties of a substance are evaluated using its hysteresis loop. Ferromagnetic materials show an hysteresis behavior when they are subjected to an external field. Hysteresis loop (also called magnetization loop) is found by plotting
either the magnetic flux density ($B$) or the magnetization ($M$) of the material versus the applied field ($H$).

There are certain critical points on the hysteresis loop as shown in Figure 3.1. Remanent field ($B_r$) denotes the remaining flux density at zero external field after magnetization of the material. Coercive field ($H_c$) denotes the magnetic field required to completely cancel the magnetization of the material. The magnetic energy density of a magnet is related to the product of $B$ (magnetic flux density) and $H$ (magnetic induction) in the second quadrant of the hysteresis curve as shown in Figure 3.1. This product, which is usually denoted as $BH_{max}$ or energy maximum product, is a figure of merit to evaluate the strength of a magnet.

In order to achieve levitation in a large gap, the magnetic layer of the proposed microrobot should meet certain specifications such as:

- High coercive field ($H_c$) to keep the magnetization direction unchanged.
- High remanent field ($B_r$) to lead to higher levitation force.
- High thickness to have higher volume and dipole moment and to levitate higher weight.
- Good adhesion to the substrate.
- Low cost.
- High vertical or horizontal magnetic anisotropy depending on the design of the levitated microrobot.
3.1.1 Atomic Magnetization Theory

In order to develop high quality magnets, it is crucial to have an understanding of atomic magnetization.

Magnetic field is generated by moving electrons. It is common knowledge that a current-carrying wire generates magnetic field encircling the wire. The spontaneous magnetization of some materials, such as iron and nickel is based on the same principle of electron motion. In an atom, electrons orbit around nucleus generating an orbital magnetic moment. Also, the spinning of electrons around themselves generates a spinning magnetic moment. Due to Pauli exclusion principle, two paired electrons in an orbit have opposite spins canceling their magnetic moments. Therefore, for an element to show net magnetization, it should have unpaired electrons. That is why transition metals, which have unpaired d-orbit electrons (3d), and rare earth elements, which have unpaired f-orbit electrons (4f), show spontaneous magnetization [31].

Materials can be classified into four main groups depending on their magnetic properties: diamagnetic, paramagnetic, ferrimagnetic and ferromagnetic. Diamagnetic and paramagnetic materials have a relative permeability ($\mu_r$) very close to 1 and do not show any remanent magnetization ($B_r$). Ferrimagnetic materials have a higher relative permeability, but because of the existence of both parallel and anti-parallel magnetization, they are not as strongly magnetized as ferromagnets. Ferromagnets show the highest relative permeability values among the four types. A ferromagnetic material is generally subdivided into regions which can have different magnetization directions. These regions are called magnetic domains. The reason for the material to form domains is to minimize its total energy. There are three types of magnetic energies that need to be covered to understand domain nucleation: exchange energy, demagnetization energy and magnetocrystalline anisotropy energy.

Exchange energy ($W_e$) is the energy caused by the exchange interaction of neighboring atoms. Two close atoms having magnetic moments of $m_1$ and $m_2$ have an exchange energy of

$$W_e = -2\beta|m_1||m_2|\cos\theta ,$$

(3.1)

where $\beta$ is a constant and $\theta$ is the angle between the magnetization directions. The summation of all such interactions gives total exchange energy for a material. As
Eq. 3.1 implies, this energy is minimized when all moments are pointing in the same direction, i.e. $\theta = 0$.

If all moments are perfectly aligned in a single direction, the material has a uniform magnetization as Figure 3.2(a) illustrates. This generates a high amount of stray field, $H$, around the material as shown by streamlines. The energy associated with this field is called demagnetizing energy $^1$ and can be calculated by

$$W_d = \frac{1}{2} \int H^2 dV,$$

(3.2)

However, if the material is magnetized as shown in Figure 3.2(b) or (c), stray field and the corresponding energy gets smaller. Each region with a uniform magnetization is called a magnetic domain. Therefore, the material will divide itself into magnetic domains as long as the increase in the exchange energy is less than the decrease in the demagnetizing energy. Consequently, the total energy of the material is decreased.

It should also be noted that demagnetizing energy is related to the shape of the material. For a non-spherical material the demagnetizing energy is higher if the material is magnetized along its short axis than magnetization along hard axis. The parallel plate capacitor analogy is very helpful to understand this phenomenon [33]. Capacitance of a parallel plate capacitor increases if larger plates (surface poles) are positioned closer to each other (along short axis). Similarly, a non-spherical

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$^1$The surface magnetic poles generating stray field forms a magnetic field in the material which is reverse to the original magnetization. That is why $W_d$ is called as demagnetizing energy.
material minimizes its energy if it is magnetized along its long axis which is also referred as easy-axis.

Another type of energy is magnetocrystalline anisotropy energy which arises from crystallinity of materials. It suggests that certain directions will be preferred for magnetization depending on the crystal type. For instance, body-centered cubic (bcc) structures prefer [100] direction, while face-centered cubic (fcc) prefers [111] and hexagonal closed pack (hcp) favors magnetization in [0001] direction [34].

3.1.2 Deposition Methods

Magnetic materials can be incorporated into MEMS devices in various ways such as microassembly, screen printing, sputtering, electroless deposition and electrodeposition.

Microassembly involves handling, positioning and integration of commercial permanent magnets. Although, powerful hard magnets can be integrated using this method, there are certain limitations on shape and the size of the magnet that can be handled [35–37]. Also, it is a complex process and requires skilled operators due to the high precision required.

In screen printing, polymer magnetic composite (prepared by mixing magnetic powders into polymeric matrix) is screen printed and cured subsequently. The patterning is achieved by conventional photolithography. Although, screen printing is more flexible than microassembly, the minimum feature size achievable through photolithography and high temperature curing of polymer composite puts a limit to the applicability of this method [9,38–42].

Sputtering is a very common technique. However, deposition of thick magnets using sputtering is significantly time-consuming and deposited magnets may require high temperature annealing to maximize magnetic performance which makes the process MEMS incompatible [43–45].

Electroless deposition would be a very good choice if the plating bath were not complex and process parameters such as pH, temperature and current density were not very strict. Besides these challenges, it is also very hard to control the deposition rate in electroless deposition [46,47].
Electrodeposition provides a good compromise in many aspects. The advantages of electrodeposition can be summarized as:

- Very easy, room temperature process.
- Relatively high deposition rates.
- Deposition can be done with low cost, easily maintained equipment without vacuum requirements.
- Excellent shape fidelity with highly conformal and uniform layers of magnets on complicated shapes [48].
- A flexible method enabling easy tailoring of film properties by varying process parameters.

Due to the explained reasons, electrodeposition was selected as fabrication method for the production of magnetic thin films.

### 3.1.3 Material Selection

After determining the deposition method, the next step is to select the material. Iron group (Fe, Co, Ni) - rare earth (Nd, Sm) alloyed magnets such as NdFeB and SmCo can be a good choice due to their paramount magnetic properties. However, it is difficult to electrochemically deposit rare earth elements from aqueous electrolytes because of their highly negative standard deposition potentials. Electrodeposition of rare earth magnets is achieved by non-aqueous electrolytes, but the resultant magnetic properties are less appealing. The bath complexity is another issue to be addressed for non-aqueous electrolytes. Increasing bath complexity draws a boundary to variation of deposition parameters and makes the film properties hard to be controlled.

Literature reports that cobalt (Co)-based alloys have satisfactory magnetic properties and show high vertical magnetocrystalline anisotropy. These alloys - such as Co-P, Co-Pt, Co-Ni, Co-Pt-P, Co-Ni-P, Co-Mn-P, Co-Ni-Mn-P can be electrodeposited from aqueous solutions. The electrolyte of Co-based alloys is formed by salts of constituent elements and additive compounds to enhance mechanical
properties of deposit. Myung et al. provided a comparison of magnetic properties of Co-based hard magnetic alloys [48]. It is revealed that Co-X-P (X = Ni, Mn, Pt, NiMn) type alloys proven far superior in providing highest $H_c$ and $B_r$ both for in-plane (horizontal) and out-of-plane (vertical) magnetization. Another important requirement for magnetic levitation is to have high thickness of film to obtain maximum stored energy. The magnetic dipole moment of the film is proportional to its volume, therefore in order to have higher dipole moments and greater levitation force, thicker films are required. It is seen that Co-Ni-Mn-P hard magnets can preserve their magnetic properties up to a few tens of micrometer thickness while others deteriorate as thickness of the film increases [49]. Besides, Ni and Mn added films are more cost effective than Pt added ones. Consequently, Cobalt-Nickel-Manganese-Phosphorus, Co-Ni-Mn-P, was chosen as the magnetic layer material since it satisfies all the aforementioned requirements of the magnetic layer of the microrobot to be levitated.

3.2 Fabrication

3.2.1 Overview of Electrodeposition

In last decades, electrodeposition has evolved from a primitive method to a versatile, precise and popular microfabrication technique. The developments in electrodeposition mostly originated from the metal interconnect deposition in integrated circuit industry [50], magnetic alloy deposition for magnetic storage media [51] and deposition of multilayer structures [52]. The studies proved that electrodeposition is superior to other deposition techniques such as sputtering, e-beam evaporation, chemical vapor deposition not only by cost-effectiveness but also in terms of flexibility, ease-of-operation and excellent shape fidelity.

Electrochemical deposition (electrodeposition in short) is the growth of a metallic layer on a conductive substrate using electrical current. An electrodeposition system consists of three main components:

1. A solution (called electrolyte) that contains the salts (chloride or sulfate) of the material to be deposited.
2. Two electrodes with positive and negative voltage biasing. These electrodes are called anode and cathode, respectively.

3. Electric circuitry to maintain a potential difference between electrodes.

This basic setup can be improved with peripherals such as agitation paddle, recycling pump, heater, reference electrode or additives mixed in the electrolyte.

The schematic of a simple setup is shown in Figure 3.3. When a potential difference is applied between electrodes the positively charged ions in the solution are attracted by the cathode and reduced on the substrate. Meanwhile electrons are removed from the solution at the anode side by oxidation of anode material to preserve charge neutrality.

First studies of electrodeposition of magnetic layers are reviewed by Edelman and Wolf [53, 54]. Although deposition of magnetic layers goes back to 1940’s, electrodeposition of Co-Ni-Mn-P was first mentioned by Horkans et al in 1990 [55]. Horkans studied Co-Ni-Mn-P films for perpendicular magnetic media storage and obtained a perpendicular coercivity ($H_{c\perp}$) of 2100 Oe.

Efficiency of electrodeposition can be measured in different ways. The most common method is current efficiency (CE) which is defined as the ratio of the actual amount of metal ($M_a$) deposited to the theoretical amount ($M_t$) calculated

---

**Figure 3.3: Schematic of the electrodeposition process.**
by Faraday’s Law.

\[ CE = \frac{M_a}{M_t} \times 100 \]  
(3.3)

\[ M_t = \frac{ItM}{nF} \]  
(3.4)

with \( I \) total current, \( t \) duration of the deposition, \( M \) molecular weight of the deposited material, \( n \) charge of the deposited ions, \( F \) the Faraday’s constant.

The electrodeposition of an alloy, i.e. codeposition, is based on the same basic principle. In codeposition of Co and Ni, although Ni is the most easily reduced ion, the Ni content in the bath is kept very high compared to the Ni content required in the deposit. This is because of the decrease in the deposition rate of Ni in CoNi solutions, a phenomenon called anomalous deposition. Despite the higher rate of deposition of pure Ni, in CoNi alloys, Co deposits faster than Ni.

### 3.2.2 Parameters of Electroplating

The main factors that influence film properties can be enumerated as current density, bath composition, agitation, current waveform, surface structure of substrate, temperature and pH.

The available ion concentrations in the bath have a profound effect on the deposit composition. Therefore by modifying bath concentration, the film properties can be tailored.

Current density is another crucial parameter. Low current density causes a significant decrease in deposition rate and increases impurity concentration in the deposit. On the other hand, high current density may cause hydrogen discharge which causes metal hydroxide formation in the film. Also, at a certain current density the deposition process becomes mass transport limited meaning that the ions reaching the electrode are reacted instantly. A further increase of current density increases the cathode potential until other reactions are excited.

Agitation of the solution bath is necessary because concentration of reactants forms a gradient around the cathode when deposition is in mass transport limited case. This causes a nonuniform film composition. Besides, agitation removes the hydrogen bubbles adhering to substrate surface and also helps to homogenize the solution.
The current waveform applied to the electrodes has a profound effect on the film properties, as well. Applying a pulsed current waveform instead of DC can help to remove hydrogen bubbles, to obtain better leveling and to modify the grain size by varying the duty cycle. In cases where DC current is used, agitation is especially important because depending on the diffusion coefficient of ions in the vicinity of the cathode, depletion of ions may result in poor film properties.

The surface of the substrate should be clean and smooth for minimum contamination and obtaining uniform film thickness. The physical and chemical properties of the substrate are especially important for epitaxial film growth.

High temperature can be helpful to increase deposition rate, improve anode oxidation and to excite dilute baths [56].

The acidity of the solution should be controlled because \( \text{H}^+ \) ions in the solutions compete with metal ions for the electrons available at cathode. The \( \text{H}^+ \) reduction at cathode wastes electrons and decreases current efficiency. Also \( \text{H}_2 \) bubbles formed after reduction may adhere to the substrate surface and hinder further deposition. Therefore, current efficiencies and film properties deteriorate noticeably when deposition is done at low pH. The upper limit for hydrogen concentration is determined by the increasing tendency of some ions to oxidize at higher pH. The pH range of 2.5 - 7 is determined to be optimum for Co-Ni alloy deposition [57].

It has been revealed that among those parameters, temperature and pH have a minor effect on Co-Ni based alloys. The deposit properties are almost invariant to the temperature and pH changes in the ranges of 10 - 70\(^\circ\)C and 2.5 - 7, respectively.

In electroplated films, stress induced in the structure is a very big challenge. Specifically for magnetic films, stress should be prevented at all cost because magnetization is closely related to shape changes due to stress (due to magnetoelastic interaction). Stress facilitates domain wall displacement and reduces \( H_c \) markedly.

### 3.2.3 Experimental Procedure

An experimental setup was prepared for electrodeposition of the Co-Ni-Mn-P thin films (Figure 3.4). The steps of electrodeposition are summarized below:

- RCA cleaning of silicon wafers (4-inch 100).
• E-beam evaporation of 30 nm chromium layer for adhesion of the seed layer.

• DC sputtering of 300 nm copper seed layer for conductivity.

• Dicing wafers into pieces of $5 \times 5 \text{ mm}^2$ squares.

• Preparation of the electrodeposition bath and stirring for 120 min.

• Dip wafer into piranha solution (3:1 ratio of $\text{H}_2\text{SO}_4$ and $\text{H}_2\text{O}_2$) for 2 min. (to clean the surface and achieve better adhesion by surface activation).

• Electrical contacts are made to the diced substrates using silver paste.

• Placement of the cobalt electrode and the substrate into the electrodeposition bath.

• Electrical connections and adjustment of applied current between 3 - 8 mA/cm$^2$.

• Continuous bath stirring during deposition by N$_2$ agitation.

Previously, the deposition studies are performed with whole wafers by most of the research groups. However, in this project dicing the wafers before electroplating
Table 3.1: Composition of electroplating bath

<table>
<thead>
<tr>
<th>Compound</th>
<th>gram/L</th>
</tr>
</thead>
<tbody>
<tr>
<td>CoCl$_2$.6H$_2$O</td>
<td>4 - 24</td>
</tr>
<tr>
<td>NiCl$_2$.6H$_2$O</td>
<td>24</td>
</tr>
<tr>
<td>MnSO$_4$.H$_2$O</td>
<td>3.6</td>
</tr>
<tr>
<td>NaH$_2$PO$_4$.H$_2$O</td>
<td>4.6</td>
</tr>
<tr>
<td>Boric acid (B(OH)$_3$)</td>
<td>22</td>
</tr>
<tr>
<td>Sodium lauryl sulfate</td>
<td>0.2</td>
</tr>
<tr>
<td>Saccharin (o-benzoic sulfimide)</td>
<td>0.8</td>
</tr>
<tr>
<td>Sodium chloride (NaCl)</td>
<td>22</td>
</tr>
</tbody>
</table>

gave us the chance to run a series of experiments by just using one wafer. The deposition parameters are optimized by various controlled experiments.

For electroplating of Co-Ni-Mn-P, the bath composition was modified from Horkans et al (Table 3.1) [58]. The first four compounds in Table 3.1 were added as the source of the required ions of cobalt, nickel, manganese and phosphorus, respectively. Boric acid and sodium chloride were added to adjust bath pH and conductivity. Sodium lauryl sulfate was the wetting agent to minimize hydrogen pitting which cause corrosion on film surface. Saccharin (or o-benzoic sulfimide, C$_7$H$_5$NO$_3$S) was the stress reducer to increase surface activity and hinder passive film formation. A cobalt strip of 50 × 5 × 1 mm$^3$ was used as anode to prevent oxidation of hypophosphite and keep up the solution ion composition [55].

The deposition was performed at room temperature with a constant pH level of 3.5 for all samples. The interelectrode separation distance was kept constant at 7 cm. Electrolyte composition, current density, bath stirring were selected as the parameters to be varied to modify film properties. Cobalt chloride concentration of the electrolyte was varied between 4 and 24 g/l to observe its impact on the ratio of Co and Ni in the deposited alloy. A DC current density between 3 and 8 mA/cm$^2$ was applied. Continuous agitation of the bath was achieved by nitrogen pumping for selected depositions.
3.3 Characterization

Nearly all of the studies about Co-based hard magnetic thin films deal with the relationship between magnetic properties \((H_c, B_r, \mu)\) and deposition parameters (bath composition, current density, temperature, pH). However, deposition parameters have a cumulative effect on magnetic properties. Therefore, there is not a single rule that can give dependence of these properties on fabrication parameters. It is especially true for alloy depositions because of the cross correlation of all variables.

For magnetic thin films; crystal structure, grain type, microcracks and stress have a profound effect on magnetic properties. Therefore, a better insight can be obtained if electrodeposition parameters are first related to structural properties and then the correlation between magnetic properties and structural properties is established as suggested by Armyanov et al [59]. In this project, the in-between structural parameters used for this method are selected to be deposit concentration, phase composition, grain structure and microcrack density as illustrated in Figure 3.5.
3.3.1 Scanning Electron Microscope - Energy Dispersive Spectroscopy

Scanning electron microscope (SEM, JSM-6460) combined with energy dispersive x-ray spectroscopy (EDS, Oxford Instruments) was used to examine the surface morphology and local elemental composition of the films.

First of all, the surface morphology was investigated by SEM. It was seen that there exist microcracks in the deposited film due to the high residual stress. Although dislocations in the structure might be helpful to increase $H_c$ by hindering domain wall motion, the high density of cracks as shown in Figure 3.6 is unwanted because it generates discontinuity in the structure and deteriorates magnetic properties. To overcome this problem, the deposition bath was constantly agitated with N$_2$ pumping at low speeds and a lower current density was applied.

Agitation removes the hydrogen bubbles adhere to the surface and homogenizes the solution. Additionally, agitation removes the effect of diffusion layer thickness which is formed in the vicinity of cathode because of the depletion of ions [56]. The surface morphology of the deposits clearly shows that agitation significantly reduces the microcrack density (Figure 3.7).

Cracks originate from non-coherent nucleation at growth surface because such a nucleation generates stacking faults and other defects. Increasing current density, increases nucleation rate and density of defects. Therefore, high current density induces more cracks.

It was observed that films deposited with low current density and constant agitation have a surface free of microcracks as shown in Figure 3.7.

After depositing the thin films, the content of the deposits was investigated by EDS (Oxford Instrument). The films were expected to include Co, Ni, Mn and P at various ratios depending on the composition of the bath, processing parameters (current density, temperature, pH etc.) and the crystal structure.

Before the EDS measurements, energies of $K_\alpha$ and $L_\alpha$ x-rays and corresponding critical energies were determined using the look-up tables [60]. Table 3.2 illustrates that the x-ray energies of Co, Ni, Mn and P are very close to each other. When the energy of a certain x-ray is greater than the edge energy of another x-ray, it is very likely for the initial x-ray to be absorbed in the structure causing fluorescence
Figure 3.6: Surface morphology of the film deposited at high current without agitation.

Figure 3.7: Surface morphology of the film deposited at low current with agitation.
of the second x-ray. The possible absorption and fluorescence scenarios for $K_{\alpha}$ and $L_{\alpha}$ x-rays can be expressed as follows:

- Ni $K_{\alpha}$ can be absorbed by Mn $\rightarrow$ fluorescence of Mn $K_{\alpha}$.

- Mn $K_{\alpha}$ can be absorbed by P $\rightarrow$ fluorescence of P $K_{\alpha}$.

- P $K_{\alpha}$ can be absorbed by Co, Ni, Mn $\rightarrow$ fluorescence of Co $L_{\alpha}$, Ni $L_{\alpha}$, Mn $L_{\alpha}$.

- Co $L_{\alpha}$ can be absorbed by Mn $\rightarrow$ fluorescence of Mn $L_{\alpha}$.

- Ni $L_{\alpha}$ can be absorbed by Co, Mn $\rightarrow$ fluorescence of Co $L_{\alpha}$, Mn $L_{\alpha}$.

As the number of elements in the deposit increases the probability of absorption and fluorescence increases. The EDS software (INCAEnergy 4.06) was used for auto-correction of fluorescence affect.

The deposited films have a nonuniform composition, since the current density on the deposition surface is not uniform. Therefore, the EDS analysis was made by marking various spots on the film surface (Figure 3.8) and averaging them as shown in Table 3.3.

The film shown in Figure 3.8 was deposited using the bath composition given in Table 3.1 with 24 g/L of CoCl$_2 \cdot$6H$_2$O. The mean values shown in Table 3.3 were taken as the resultant film content. Although same amount of cobalt and nickel were added into the bath, Co (86.54 %) is more abundant in the deposit compared to Ni (11.85 %). This is due to the anomalous deposition explained in Section 3.2. Despite the higher deposition rate of pure Ni compared to pure Co, when they are codeposited Co deposits faster than Ni.
In the crystal lattice, Ni can replace Co atoms because of their similar atomic radius size and electronegativity. Different forms of Co-Ni-Mn-P thin films were obtained by increasing the Ni content in the deposit. For this purpose, the concentration of cobalt chloride (CoCl$_2$.6H$_2$O) in the electrodeposition bath was decreased gradually, while repeating the EDS measurement for each deposited film. All other additives are used at constant compositions as showed in Table 3.1. The concentr-
Table 3.3: EDS results for the deposited Co-Ni-Mn-P film (in weight %)

<table>
<thead>
<tr>
<th>Region</th>
<th>Co</th>
<th>Ni</th>
<th>Mn</th>
<th>P</th>
<th>Total</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>87.19</td>
<td>12.72</td>
<td>0.09</td>
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<td>100.00</td>
</tr>
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<td>0.28</td>
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<td>11.93</td>
<td>0.24</td>
<td>1.29</td>
<td>100.00</td>
</tr>
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<td>0.73</td>
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<td>100.00</td>
</tr>
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<td>0.02</td>
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</tr>
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<td>0.21</td>
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<tr>
<td>8</td>
<td>85.80</td>
<td>12.02</td>
<td>0.11</td>
<td>2.08</td>
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</tr>
<tr>
<td>9</td>
<td>88.80</td>
<td>10.21</td>
<td>0.34</td>
<td>0.66</td>
<td>100.00</td>
</tr>
<tr>
<td>10</td>
<td>99.39</td>
<td>9.82</td>
<td>0.02</td>
<td>1.77</td>
<td>100.00</td>
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<tr>
<td>11</td>
<td>84.77</td>
<td>13.42</td>
<td>0.08</td>
<td>1.73</td>
<td>100.00</td>
</tr>
<tr>
<td>12</td>
<td>84.26</td>
<td>12.84</td>
<td>0.33</td>
<td>2.57</td>
<td>100.00</td>
</tr>
<tr>
<td>13</td>
<td>86.58</td>
<td>11.83</td>
<td>0.23</td>
<td>1.37</td>
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</tr>
<tr>
<td>14</td>
<td>85.73</td>
<td>11.28</td>
<td>0.27</td>
<td>2.73</td>
<td>100.00</td>
</tr>
<tr>
<td>15</td>
<td>84.20</td>
<td>12.63</td>
<td>0.30</td>
<td>2.88</td>
<td>100.00</td>
</tr>
<tr>
<td>16</td>
<td>85.13</td>
<td>11.44</td>
<td>0.34</td>
<td>3.09</td>
<td>100.00</td>
</tr>
</tbody>
</table>

| Mean   | 86.54 | 11.85 | 0.14 | 1.46 | 100.00|
| Std. deviation | 1.53 | 1.02 | 0.26 | 1.03 | 100.00|

EDS results revealed that Ni can replace atoms in Co lattice. However, Mn and P are deposited at very low ratios. These results are consistent with previous studies that show that Mn and P mostly segregate at grain boundaries as nonmagnetic or weakly magnetic regions, while Ni is incorporated into the Co lattice [48,61].

It was shown that Ni content can be modified in a high range. The high Ni content in the film might have a major effect on the film properties because it
might modify the crystal structure. The phase diagram of Co-Ni alloys is provided in Figure 3.10. At room temperature, different forms of Co can be obtained by varying the weight of Ni. The phase transition of Co is observed around 30% of Ni content at room temperature. Therefore, it is possible to observe different crystal formations of Co-Ni-Mn-P films and tailor the magnetic properties of the films according to the application.

To study the influence of crystal structure on magnetic properties, two samples are chosen with Ni contents of 11.83% and 30.14%. The deposition conditions and concentrations of the selected films are summarized in Table 3.5.

Firstly, SEM was used to observe the cross-section of the selected films. Figures 3.11 and 3.12 respectively illustrate the grain structures. The low Ni content film clearly demonstrates a columnar grain structure along its thickness (Figure 3.11). On the other hand, Ni-rich sample did not show a preferred grain orientation (Figure 3.12).

### 3.3.2 X-Ray Diffraction

X-ray diffraction (XRD, Rigaku SA-HF3) was used to determine crystal structure of the two selected samples. The spectra were obtained with a Cu-K$_\alpha$ x-ray radiation of 1.54 Å wavelength and 0.2 mm radius collimator. The exposure time was set
### Table 3.4: Film content for varying Ni

<table>
<thead>
<tr>
<th>CoCl₂·6H₂O concentration (g/L)</th>
<th>Obtained concentrations (wt %)</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Co</td>
</tr>
<tr>
<td>24</td>
<td>86.54</td>
</tr>
<tr>
<td>22.5</td>
<td>85.21</td>
</tr>
<tr>
<td>21</td>
<td>83.49</td>
</tr>
<tr>
<td>19.5</td>
<td>83.14</td>
</tr>
<tr>
<td>18</td>
<td>80.45</td>
</tr>
<tr>
<td>16.5</td>
<td>81.05</td>
</tr>
<tr>
<td>15</td>
<td>76.9</td>
</tr>
<tr>
<td>13.5</td>
<td>72.92</td>
</tr>
<tr>
<td>12</td>
<td>75.64</td>
</tr>
<tr>
<td>10.5</td>
<td>65.17</td>
</tr>
<tr>
<td>9</td>
<td>61.63</td>
</tr>
<tr>
<td>7.5</td>
<td>49.83</td>
</tr>
<tr>
<td>6</td>
<td>50.73</td>
</tr>
<tr>
<td>4.5</td>
<td>35.56</td>
</tr>
<tr>
<td>3</td>
<td>35.51</td>
</tr>
<tr>
<td>1.5</td>
<td>21.18</td>
</tr>
<tr>
<td>0.75</td>
<td>14.03</td>
</tr>
</tbody>
</table>

### Table 3.5: Selected samples for XRD

<table>
<thead>
<tr>
<th>Sample</th>
<th>Co</th>
<th>Ni</th>
<th>Mn</th>
<th>P</th>
<th>Current Density</th>
<th>Deposition duration</th>
</tr>
</thead>
<tbody>
<tr>
<td>Low Ni</td>
<td>86.34</td>
<td>11.83</td>
<td>0.15</td>
<td>1.66</td>
<td>4 mA/cm²</td>
<td>4.5 h</td>
</tr>
<tr>
<td>High Ni</td>
<td>67.07</td>
<td>30.14</td>
<td>0.20</td>
<td>2.59</td>
<td>3 mA/cm²</td>
<td>6 h</td>
</tr>
</tbody>
</table>
Figure 3.11: Cross-sectional view of the low Ni content film.

Figure 3.12: Cross-sectional view of the high Ni content film.

to 480 s and diffraction angles between 35° and 115° were spanned with 0.02° increments.

Co-Ni-Mn-P thin films are reported to show hexagonal structure with preferably the c-axis orientation parallel to film surface normal [62]. However, the weight percentage of each element of the alloy is an important factor affecting the crystal structure. The phase diagram of Co-Ni alloys suggests that incorporation of Ni in the Co lattice at room temperature may result in cubic phase if Ni content is
greater than 35% [63]. Co-Ni-Mn-P films are expected to show a similar property since Mn and P content is kept below a few percent.

The thickness of the films were measured to be approximately 20 µm. Obtaining relatively high thickness is important not only for better XRD results, but also for obtaining higher stored magnetic energy which is proportional to the film volume. The initial layers of the deposited film are very much dependent on the substrate properties. This region of the deposit, usually up to 1 µm, is called as “initial texture”. The subsequent region deposited on initial texture is called “growth texture” [64]. The films are deposited thick enough to minimize the effect of substrate and to analyze growth texture only. Relatively thick films hinder any peaks due to the crystalline substrate. The demonstrated data belong to the deposited films only and can easily be interpreted.

Crystal structures of various concentrations of Co-Ni-Mn-P films deposited at a current density of 6 mA/cm² were studied using XRD. Interestingly, none of the samples gave any peaks, because of the non-crystalline structure of the thin films. A set of annealing experiments were done for various durations and temperatures, however no improvement in the XRD results can be obtained, either.

It is known that the electrodeposition kinetics are greatly influenced by the current density and agitation. To obtain crystalline thin films, a series of experiments were performed with varying current density and nitrogen agitation. It was observed that the lower the current density, the higher impurity content measured in the film. On the other side, increasing current density introduces more stress in the film and causes high density of microcracks. Accordingly, the current density is varied between 3 and 8 mA/cm². It is worth mentioning that the deposition duration was varied correspondingly to keep the film thickness constant around 20 µm as current density was changed.

As the current density was decreased, XRD patterns were started to be observed. To test the effect of agitation, after the solution was prepared it was poured into two containers only one of which is agitated by nitrogen pumping (Figure 3.4). XRD peaks were obtained for only the baths that are not agitated. Therefore the optimum deposition conditions to obtain a crystalline structure can be summarized as low current density and no agitation.

Zana states that reduced current density increases grain size and crystallinity
Figure 3.13: XRD data of low Ni content film.

Similarly, our results showed that crystallinity is promoted by low current density and it might be mainly because low current density reduces hydrogen bubble formation and induces smaller stress. Therefore, less discontinuity is formed in the film structure resulting in a highly crystallized material.

The XRD results of the first sample with low Ni content is provided in Figure 3.13. Although, the noise level is high, six peaks are clearly distinguished. The diffraction angles, actual intensities and relative intensities of these peaks are summarized in Table 3.6. The interplanar spacings were calculated using Bragg’s Law

\[ n\lambda = 2dsin\theta. \]  

In order to determine the crystal structure, experimental data is compared to both analytical results and the reference data match provided by the XRD software (Appendix B). Comparing the results to the theoretical XRD peaks of pure hexagonal closed pack (hcp) Co (Table 3.7), the measured peaks were determined to be (10.0), (00.2), (10.1), (11.0), (11.2) and (20.1). Thus, it was shown that the films with low Ni content forms an hcp structure as the phase diagram suggests. The reason for not observing the other peaks and obtaining different intensities can be due to more than 13% impurity content in the film (Ni, Mn and P can be
Table 3.6: Experimental results of the film with low Ni content (11.83 %)

<table>
<thead>
<tr>
<th>Peak</th>
<th>$2 \theta^\circ$</th>
<th>d (Å)</th>
<th>I (counts)</th>
<th>I (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>41.76</td>
<td>2.161</td>
<td>14799</td>
<td>75.6</td>
</tr>
<tr>
<td>2</td>
<td>44.72</td>
<td>2.025</td>
<td>4561</td>
<td>23.3</td>
</tr>
<tr>
<td>3</td>
<td>47.56</td>
<td>1.910</td>
<td>19579</td>
<td>100.0</td>
</tr>
<tr>
<td>4</td>
<td>76.04</td>
<td>1.251</td>
<td>15217</td>
<td>77.7</td>
</tr>
<tr>
<td>5</td>
<td>92.66</td>
<td>1.065</td>
<td>15438</td>
<td>78.8</td>
</tr>
<tr>
<td>6</td>
<td>94.78</td>
<td>1.047</td>
<td>4850</td>
<td>24.8</td>
</tr>
</tbody>
</table>

Table 3.7: Ideal XRD values for pure Co

Hexagonal Co, $c = 4.07$, $a = 2.507$ Å

<table>
<thead>
<tr>
<th>$2 \theta^\circ$</th>
<th>d (Å)</th>
<th>I (%)</th>
<th>(hk.l)</th>
</tr>
</thead>
<tbody>
<tr>
<td>41.56</td>
<td>2.171</td>
<td>24.8</td>
<td>10.0</td>
</tr>
<tr>
<td>44.48</td>
<td>2.035</td>
<td>27.8</td>
<td>00.2</td>
</tr>
<tr>
<td>47.42</td>
<td>1.917</td>
<td>100.0</td>
<td>10.1</td>
</tr>
<tr>
<td>62.50</td>
<td>1.487</td>
<td>11.5</td>
<td>10.2</td>
</tr>
<tr>
<td>75.83</td>
<td>1.254</td>
<td>11.6</td>
<td>11.0</td>
</tr>
<tr>
<td>84.06</td>
<td>1.151</td>
<td>12.9</td>
<td>10.3</td>
</tr>
<tr>
<td>90.40</td>
<td>1.086</td>
<td>1.9</td>
<td>20.0</td>
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<tr>
<td>92.39</td>
<td>1.067</td>
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<tr>
<td>98.51</td>
<td>1.018</td>
<td>2.3</td>
<td>00.4</td>
</tr>
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</table>

considered as impurity when comparing to pure Co). The impurity content affects the c/a ratio of the hexagonal structure and the unobserved peaks might be very sensitive to this variation.

When CoCl$_2$.6H$_2$O concentration in the bath was decreased to 10 g/l from 24 g/l and a current density of 3 mA/cm$^2$ was applied for 6 h, a Ni-rich alloy was obtained. The same measurements were repeated for this second sample. It can be seen that there is a significant amount of change in the crystal structure since number of peaks are reduced to four. The experimental peak locations and intensities are
summarized in Table 3.8. XRD measurements of this Ni-rich film clearly showed the attenuation of the hcp peaks in the XRD results of the first sample.

For the second sample, the EDS results revealed that the Co to Ni ratio was around two in the deposit and the lattice parameters for Co (3.544 Å) and Ni (3.524 Å) are close to each other. Therefore, it is expected to observe a substitutional solid solution of Co and Ni in the film structure.

Solid solutions can be classified as ordered and disordered. If atoms of one type prefer certain atomic locations, a long-range order is seen which leads to ordered solid solutions as shown in Figure 3.15.

It is known that ordered and disordered solutions will have different diffraction
patterns. A complete disordered solid solution generates diffraction patterns similar to a single element sample with the same crystal structure. On the other hand, an ordered solid solution will have some extra peaks (called superlattice lines) in addition to the original peaks (called fundamental lines) [60]. The comparison of the experimental data with the examples in the powder diffraction database showed that the obtained result was an example of face-centered cubic (fcc) crystal structure with similarities to PDF# 65-2865 (Appendix B). Besides, no additional peaks were observed. Therefore, it was concluded that the Co-Ni-Mn-P films form a disordered solid solution of Co-Ni.

When experimental results are compared with the analytical results for disordered Co-Ni films presented in Table 3.9, the formation of cubic phase can be determined. (111), (220) and (311) peaks of the cubic structure are easily observed. The second peak is the attenuating peak of the hcp lattice. A comparison of Figures 3.13 and 3.14 reveals that by increasing the nickel content the crystal structure
Table 3.10: Magnetic properties of the deposited thin films

<table>
<thead>
<tr>
<th></th>
<th>hexagonal films</th>
<th>cubic films</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>in-plane</td>
<td>out-of-plane</td>
</tr>
<tr>
<td>$B_r$ (kG)</td>
<td>1.4 - 1.6</td>
<td>0.5 - 0.7</td>
</tr>
<tr>
<td>$H_c$ (Oe)</td>
<td>145 - 158</td>
<td>103 - 204</td>
</tr>
<tr>
<td>$BH_{max}$ (kJ/m$^3$)</td>
<td>0.44 - 0.45</td>
<td>0.13 - 0.16</td>
</tr>
</tbody>
</table>

was readily modified from hexagonal to cubic.

### 3.3.3 Magnetic Property Measurements

The magnetic properties of the films were determined by hysteresis loop measurements performed by a Quantum Design (Model 1822) Magnetic Property Measurement System (MPMS) at Brockhouse Institute of Materials Research, McMaster University.

Depending on the design of the microrobot, levitation will be horizontally or vertically. When levitating the microrobot parallel to the horizontal plane, the out-of-plane magnetization values are of interest. If the microrobot is levitated perpendicularly, the in-plane magnetization values should be enhanced. Therefore, measurement of both in-plane and out-of-plane magnetization properties is crucial for the deposited thin films.

Magnetic properties including coercive field ($H_c$), remanent field ($B_r$), and maximum energy product ($BH_{max}$) are listed in Table 3.10. Maximum energy product values are calculated from the second quadrant of the hysteresis loops. Sample in-plane and out-of-plane magnetization loops are shown in Figures 3.16 and 3.17. These plots were obtained using a film with a thickness of 25 µm.

As can be seen from Table 3.10, hexagonal films outperform cubic films in terms of perpendicular magnetization properties, whereas cubic films have superior horizontal magnetization characteristics. For instance, out-of-plane $BH_{max}$ increases up to 70% in average with a cubic to hexagonal transformation and in-plane $BH_{max}$ triples for cubic films compared to hexagonal films.

The promoted out-of-plane magnetization of hexagonal films can be attributed
Figure 3.16: In-plane magnetization.

Figure 3.17: Out-of-plane magnetization.
to the fact that magnetocrystalline anisotropy of hexagonal Co is much higher than cubic Co [59]. When [0001] axis of the films (c-axis) coincides with the normal of the film surface, perpendicular magnetization is improved. In addition, the perpendicularly oriented grain structures of hexagonal films observed in Figure 3.11 promotes shape anisotropy. Resultantly, magnetocrystalline anisotropy and shape anisotropy reinforce each other in hcp films that leads to better out-of-plane magnetic properties compared to in-plane magnetization.

It should be noted that magnetic properties of both hexagonal and cubic Co-Ni-Mn-P films are not as strong as rare-earth magnets (NdFeB, SmCo). However, electrodeposited Co-Ni-Mn-P films provide multi-directional magnetization and they are much inexpensive to produce. Therefore, they can be a good choice for disposable microsystems. In addition, as stated in previous studies, the magnetic properties listed in Table 3.10 can be improved by incorporating additional stress relievers to the solution [65], applying magnetic field during deposition [66] or producing array structures instead of monolithic films [67].

### 3.4 Levitation of Electrodeposited Thin Films

Depositing Co-Ni-Mn-P thin films, the next step is to levitate these samples using the experimental setup explained in Section 2.2. For the levitation of the thin films, we confronted the challenge of having enough magnetic field in the large air gap. The levitation of permanent magnets have been demonstrated in Section 2.4, however, the magnetic field may not be sufficient for the levitation of electrodeposited films for two reasons:

- The volume magnetization (M), therefore the magnetic dipole (m) of the Co-Ni-Mn-P films are not as high as NdFeB magnets. Thus, there is a need for significantly higher magnetic field.

- For the NdFeB permanent magnets, the complete structure is the ferromagnetic material, however for the films, there is a silicon layer of 500 µm thickness. Therefore the 20 - 30 µm thick Co-Ni-Mn-P layer should also carry the silicon layer.
For the levitation of Co-Ni-Mn-P films, the film deposited with 2 mA/cm\(^2\) for a duration of 6 h was selected. Using Eq. 2.20, the vertical levitation equation can be written as

\[ F_{lev} = m \frac{\partial B_z}{\partial z} \quad (3.6) \]

To achieve weight balancing, the levitation force should be as high as the weight of the object, \(i.e.\)

\[ mg \hat{z} = m \frac{\partial B_z}{\partial z} \quad (3.7) \]

should be satisfied.

Magnetic property measurements showed that the films have an in-plane volume magnetization of 3250 G. In SI units, this is equivalent to

\[ M = 3250 \times \frac{10^3}{4\pi} = 258626.78 \text{ A/m}. \quad (3.8) \]

The weight of the film is 18.8 mg and its dimensions are 5\(\times\)5 \(\times\)25.10\(^{-3}\) mm\(^3\). Then, the magnetic dipole moment of the film can be calculated by

\[ m = M \times V \rightarrow m = 258626.78 \times (5 \times 5 \times 25.10^{-3}) \times 10^{-9} = 1.6164 \times 10^{-4} \text{ Am}^2 \quad (3.9) \]

The obtained values are substituted into Eq. 3.7 to obtain the required field gradient as

\[ 18.8 \times 10^{-6} \times 9.8 = 1.6164 \times 10^{-4} \times \frac{\partial B_z}{\partial z}, \quad (3.10) \]

\[ \frac{\partial B_z}{\partial z} = 1.14 \text{ T/m} = 11.4 \text{ G/mm}. \quad (3.11) \]

To test the capability of the system for levitation of the thin films, the magnetic field in the air gap region was measured by a gaussmeter (Lakeshore 421) using a five-joint robot arm (Figure 3.18). Then the corresponding field gradient was calculated as plotted in Figure 3.19.

The maximum field gradient was around 1.5 G/mm with 2 A applied to the electromagnets. According to Eq. 3.11, the field gradient was not high enough to levitate the films. In order to increase the field, a large cylindrical permanent magnet was integrated at the upper yoke end of the levitation setup (Figure 3.18). This magnet has enhanced the magnetic field in the magnetic circuit and resulted in doubling of the field gradient as illustrated in Figure 3.20. However, the maximum gradient that occurs at a distance of 50 mm from the pole piece was still not high.
Figure 3.18: The picture of the modified levitation system with gaussmeter.

Figure 3.19: Magnetic field and its gradient along vertical axis.
Figure 3.20: Magnetic field and its gradient with magnet integrated.

enough. To further increase the field, one more electromagnet was attached at the bottom of the pole piece as shown in Figure 3.18. This extra electromagnet was aligned such that its center coincides with the central axis of the air gap. This modification has improved the magnetic field and its gradient in two ways:

1. By reducing fringing field with a reduction of air gap.

2. By concentrating the magnetic field along the central axis with a sharp edge effect.

Magnetic fields as high as 700 G can be obtained with the modified system as shown in Figure 3.21. The field gradient is also shown together with the critical level of 11.4 G/mm. The inset clearly demonstrates that the required field gradient can be achieved with even 0.5 A. The drawback of the extra electromagnet is limiting the maximum range of operation by decreasing the gap region. The intersection point of field gradient curves with the critical limit determines the motion range of the films. With 0.5 A applied to the electromagnets, the object can be levitated in a range of 5 mm (between 60 mm and 65 mm). By increasing the current to 2 A, it is possible to increase the range up to 12 mA (between 60 mm and 72 mm).

If higher quality magnets or thicker magnets were deposited, the required field gradient would be smaller and the motion range can be promoted even more.
Obtaining the sufficient field gradient is not the only requirement for stable levitation as already mentioned in Section 2.3. The magnetic field on the horizontal plane should have a single \( B_{\text{max}} \) point for the object to be levitated at a single point. Therefore, the horizontal field distribution in the working domain should be checked as well to ensure levitation.

The horizontal field measurements were performed at the distances of 60, 70 and 80 mm from the pole piece at a moderate current level of 1 A. Figure 3.22 demonstrates the results of the magnetic field measurements on the horizontal plane. The magnetic field forms a unique \( B_{\text{max}} \) point on the central axis in all cases. It was also observed that as the distance from the pole piece decreases, the field becomes less uniform and the magnetic field forms a sharper peak.

Ensuring the magnetic levitation with vertical and horizontal magnetic field measurements, the levitation experiments were performed. The out-of-plane magnetized sample whose hysteresis loop is shown in Figure 3.17 was successfully levitated at a height of \( z = -0.065 \) m from the pole piece as seen in Figure 3.23. A constant reference input was applied for 60 s (Figure 3.24) and a positioning rms error of 15.7 \( \mu \)m was measured until \( t = 50 \) s. The huge deflection at the measured data at \( t = 50 \) s is due to the rotation of the levitated object around itself. The object was levitated vertically along its surface diagonal direction. The square shape
Figure 3.22: Horizontal magnetic field at different heights.
Figure 3.23: The image of the levitating Co-Ni-Mn-P magnetic film.

Figure 3.24: Levitation of Co-Ni-Mn-P thin film at a constant level.

of the object and its spin around itself resulted in a misreading of the position level as schematically shown in Figure 3.25.

The levitation performance was also tested by 0.5 mm step inputs. Figure 3.26 illustrates that the object can follow the trajectory in a motion range of 1 mm. Non-uniform magnetization is responsible from the orientation of the sample during
levitation. The magnet is not levitated vertically in a complete manner. It has a small angle with the vertical axis which is caused by the non-uniform magnetic properties along the thickness of the film. The experiments reveal that the biggest hurdle to overcome is the self spin of the levitated object. During this spin, the laser measurement was done at different level of heights of the object. This spinning problem is addressed in Section 5.2 where square-head magnet assemblies are used for the levitating microrobot.
Figure 3.26: Levitation of Co-Ni-Mn-P thin film for step input trajectory.
Chapter 4

Design, Simulation and Characterization of Microgrippers

Micromanipulation is a tedious task when the dominating surface forces and the high precision requirement is considered. Microneedles, micropipettes, microprobes and microgrippers are some of the available tools that can be used for micromanipulation. Among these tools, microgrippers are commonly used since they can firmly handle the objects with different sizes [68]. In addition, microgrippers can be used for simpler manipulation operations such as pushing, pulling and lifting. Therefore, microgripper has been chosen as the dexterous micromanipulation tool for the magnetically levitated micromanipulator. Microgrippers are usually made of two or more compliant gripping fingers that can be moved individually or together. The objects of interest are hold at the tip of the gripping fingers which can be designed in various geometries.

In this chapter, the photo-thermally actuated polymeric bent-beam microgrippers that are specifically designed for the levitation system are explained. In Section 4.1, microgrippers reported in the literature is given. The choice of polymeric materials and photo-thermal actuation are explained together with other available materials and actuation methods. In Section 4.2, the analytical model of the photo-thermal bent-beam actuation is derived. In Section 4.3, design constraints of microgrippers are discussed and four microgripper designs are introduced. Section 4.4 explains the finite element simulations and fabrication procedure in detail. In Section 4.5, the microgripper testing setup is shown and the verification of the
analytical model is demonstrated. Finally, in Section 4.6, the four microgripper designs are characterized. A comparison of the polymeric photo-thermal microgrippers with the other microgrippers in the literature is also given in Section 4.6.

4.1 Background and Related Work

Literature reports numerous microgrippers implemented using different materials and actuation methods. The most common materials used for microgrippers are silicon [69–73], metals [74–77] and polymeric materials [78–82]. Out of these three types of materials, polymers provide a good compromise in many aspects. Polymers are both mechanically and chemically stable as opposed to metals [78, 83]. Damaging the gripped objects can be a big hurdle to overcome for metal or silicon microgrippers. However, polymer microgrippers are biocompatible and allow gentle handling of objects thanks to their elastic structures. Also, some polymers are transparent that can be a great advantage for in-situ observation. Moreover, low Young’s modulus and high thermal coefficient of expansion of polymers enable easy actuation at relatively low temperatures that is crucial for viability in biomedical applications [79,80,82]. SU-8 is a very common type of polymer being used in fabricating microdevices using softlithography technology. It is an epoxy-based negative photoresist that can be used as structural material, as well. The processing of SU-8 is much easier and cost-effective compared to that for silicon and metallic materials. In addition, high aspect ratio structures can be fabricated from SU-8 using conventional photolithography techniques. The low density of SU-8 compared to silicon and metals is another asset for the microgrippers to be levitated, since the load on the magnetic unit can be minimized using low density materials. Therefore, SU-8 was chosen as the structural material for the magnetically levitated microgrippers.

In general, the most common actuation methods for MEMS are thermal, electrostatic, magnetic, piezoelectric and pneumatic actuation, among which thermal actuation is promising due to its large displacements, high accuracy and simplicity in design [84,85]. Thermal actuation can be achieved in various ways such as hot-cold arm actuator, bimorph design and bent-beam actuator as shown in Figure 4.1. The most common way is using a hot-cold arm actuation mechanism which utilizes different thermal expansion of a narrow (hot) and a wide (cold) arm bonded together to achieve actuation [86]. Bimorph thermal actuation is another
popular mechanism which requires stacking of two materials with different thermal expansion coefficients. When the two layers are heated together, their differential thermal expansion generates the desired actuation [75]. Bent-beam designs (also called v-beam or chevron-beam) can also be used for thermal actuation [87]. In the bent-beam design, two fixed-free arms are connected at their free ends to form a v-shape where the tip is usually added to the connection point of the two arms. When the arms are heated, the tip point moves in a linear manner due to symmetric thermal expansion of the two bent-beam arms.

When the three most common thermal actuation methods are compared, it can be seen that although the hot-cold arm design has been very popular, it has intrinsic problems such as back bending and the risk of touching arms limiting its performance [88]. Back bending occurs when the narrow hot arm is deformed due to very high temperatures required for high deflections. Thus, the initial zero-deflection position of the actuator shifts and characteristics of motion changes. Similarly, for increased deflections the hot and cold arms can touch each other due to the arching motion of the two arms and the narrow air gap in-between the two arms. Drawbacks of the bimorph structure are associated with the need for multiple deposition steps which may cause delamination at the interface of the stacked layers [83,89,90]. In contrast, the bent-beam design is made of a single layer and does not suffer peel-off or mechanical failure during operation. Moreover, bent-beam actuators provide a rectilinear displacement and do not have the risk of touching arms at increased deflections [83]. The force output of the bent-beam design can be increased using parallel-beam configurations [91]. Therefore, bent-
beam design is adopted in this study.

The previously reported SU-8 microgrippers use pneumatic [92,93], piezoelectric (PZT) [81], shape memory alloy (SMA) [79] and electro-thermal actuation [78,82,94]. Among these grippers only pneumatically powered ones have a monolithic SU-8 layer, however they suffer from very complex designs. The other microgrippers use SU-8 layer only as a passive structural layer. For actuation of the microgripper another layer (PZT, SMA or metallic) is attached or deposited on SU-8 resulting in a multilayer structure. Having a multilayer structure has serious drawbacks:

- Firstly, additional fabrication steps are required with high precision which increases the cost and decreases the throughput.

- During long operation cycles, multilayer structures are susceptible to peel-off which causes failure of the device [95].

- Attachment of actuation mechanism on SU-8 requires skilled operators. It is a very challenging task particularly when the microgripper is downsized as seen in the PZT [81] and SMA [79] actuated microgrippers.

- Another major problem mostly associated with metallic/SU-8 multilayer electro-thermally actuated SU-8 microgrippers is the undesired out-of-plane deflections. When metallic layers are deposited on SU-8 to pass electric current, because of the difference between the coefficients of thermal expansion of metals and SU-8, the microgripper fingers deflect vertically as well [78].

Therefore, although SU-8 microgrippers are very promising, the previously reported actuation mechanisms face significant hurdles due to the use of multilayer structures.

To develop reliable microgrippers made of a single SU-8 layer (monolithic), a photo-thermal bent-beam actuation scheme is demonstrated in this dissertation that eliminates the use of multilayer structure as well as achieving non-contact actuation. Photo-thermal actuation, which provides required heat using a remote laser source, has been used since 1980’s [96]. The combination of photo-thermal actuation and single layer of SU-8 for microgrippers reduces the device size because the microgripper itself does not carry any circuitry or any mechanism related to
actuation. Another aspect of photo-thermal actuation that is particularly important is that the microgrippers can be operated in a completely off-chip manner without any cable connections. As a result, they have higher maneuverability and dexterity [97] and more biocompatible than electro-thermal microgrippers since the latter ones can damage the cells in ionic solutions because of the required current flow in actuation [98]. Photo-thermal actuation for polysilicon chevron actuators have been presented before [98–100], however, no results have been reported for the combination of photo-thermal actuation with polymeric (SU-8) materials partly because SU-8 is a new material of choice for microgripper applications.

4.2 Analytical Model of Photo-thermal Bent-beam Actuation

Photo-thermal actuation is proposed for the microgrippers that utilize the bent-beam actuator shown in Figure 4.2. In this design, a laser beam is focused on the circular disk which connects the two arms. The arms are connected to a fixed base at their one end. The absorbed heat at the focusing point flows through the arms and expands the two arms simultaneously causing a vertical motion of the tip. The reason for introducing a large circular disk is to allow easy alignment of the laser on the microactuator, which otherwise would be difficult in the conventional designs where the two arms are directly connected at their ends. Polymeric photo-thermal actuation is challenging because the actuator performance is highly dependent on a combination of the applied laser power, the dimensions of the arms and the circular disk, and the material properties. For example, if the laser power is too high, it may potentially damage actuators as demonstrated previously for polysilicon actuators [98] that are far less temperature sensitive than polymer materials. If it is too low, however, it might not be sufficient to achieve the goal of displacement for a given design. Therefore, it is very important to analytically evaluate the design and operation parameters prior to experimental studies.

In order to accurately determine the tip displacement, the temperature distribution of the entire design including the circular region and the two arms must be calculated and the expansion of the circular region should also be taken into account. Most of previously reported photo-thermal actuators [98,99] did not pro-
provide a model for the temperature profile along the actuator arms. Que et al [87] and Lobontiu et al [101] derived an equation for the displacement of the bent-beam actuators, however, an average increase in temperature of the two arms was used in this equation, which can not accurately predict the temperature profile of the entire design. Therefore, a theoretical model must be established which is introduced in this section. Parametric studies using the developed model lead to an appropriate design. This model is set up based on a bent-beam actuator made of a single SU-8 layer, which simplifies the fabrication procedure compared to multilayer structures since only one transparent mask is required and no alignment is needed. This design resolves the problems associated with the hot-cold arm design and bimorph structure. In addition, it does not suffer from the peeling associated with the operation of multilayer actuators.

The analysis of the tip displacement as a function of absorbed laser power is done in two steps. Firstly, the numerical photo-thermal analysis gives the temperature distribution across the device when laser is absorbed. Secondly, the temperature distribution is used in the analytical thermo-mechanical model to calculate the amount of tip displacement.

4.2.1 Photo-thermal Analysis

The heating of the bent-beam actuator is achieved by focusing a laser beam on its circular disk as shown in Figure 4.2. The actuator is suspended in air; therefore, heat loss through convection occurs from the top, bottom and side surfaces of the
device to its surroundings which are considered in the model. The radiation heat loss is neglected due to relatively low temperature of operation (less than 425 K) compared to silicon-based actuators.

It was assumed that the temperature profile is uniform through the thickness of the device, thus a two-dimensional (2D) heat analysis is implemented. The circular geometry and spreading resistance between the disc and arms [102] complicate the analytical solution of the 2D heat equation. Therefore, a numerical approach was followed to obtain the temperature distribution across the device. The finite difference method (FDM) was used to find the steady-state temperature profile. The 2D solid body was placed on a grid as shown in Figure 4.3. The intersections of grid lines are the nodal points where temperature is calculated iteratively.

Due to symmetry, half of the device is modeled as illustrated in Figure 4.3. The arm is drawn horizontally straight without loss of generality. Although FDM can handle circular geometries, the disc region is approximated by lines for simplicity. The parameters used for the numerical model are summarized in Table 4.1.

The heat equation at a single node \((m,n)\) can be found based on the energy
Table 4.1: Parameters of the numerical temperature model: material properties of SU-8, numerical modeling parameters, geometrical parameters of the actuator

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Specific heat ( (c) )</td>
<td>1500</td>
<td>J kg(^{-1}) K(^{-1})</td>
</tr>
<tr>
<td>Density ( (\rho) )</td>
<td>1200</td>
<td>kg m(^{-3})</td>
</tr>
<tr>
<td>Thermal conduction coefficient ( (k) )</td>
<td>0.2</td>
<td>W m(^{-1}) K(^{-1})</td>
</tr>
<tr>
<td>Convection coefficient ( (h) )</td>
<td>10</td>
<td>W m(^{-2}) K(^{-1})</td>
</tr>
<tr>
<td>Laser heat density ( (q^{\text{laser}}) )</td>
<td>452e6</td>
<td>W m(^{-3})</td>
</tr>
<tr>
<td>Initial temperature ( (T_0) )</td>
<td>300</td>
<td>K</td>
</tr>
<tr>
<td>Time increment ( (\Delta t) )</td>
<td>5e-5</td>
<td>s</td>
</tr>
<tr>
<td>Position increment ( (\Delta x, \Delta y) )</td>
<td>5</td>
<td>( \mu )m</td>
</tr>
<tr>
<td>Total time</td>
<td>5</td>
<td>s</td>
</tr>
<tr>
<td>Arm length ( (L_1) )</td>
<td>75</td>
<td>( \mu )m</td>
</tr>
<tr>
<td>Arm width ( (w_1) )</td>
<td>15</td>
<td>( \mu )m</td>
</tr>
<tr>
<td>Tip length ( (L_2) )</td>
<td>25</td>
<td>( \mu )m</td>
</tr>
<tr>
<td>Tip width ( (w_2) )</td>
<td>20</td>
<td>( \mu )m</td>
</tr>
<tr>
<td>Disc radius ( (r) )</td>
<td>75</td>
<td>( \mu )m</td>
</tr>
<tr>
<td>Thickness ( (\Delta z) )</td>
<td>100</td>
<td>( \mu )m</td>
</tr>
</tbody>
</table>

The energy balance as

\[
q^{\text{heating}} + q^{\text{cond}} + q^{\text{conv}} = q^{\text{stored}},
\]

(4.1)

where \( q^{\text{heating}} \) is the absorbed laser heat, \( q^{\text{cond}} \) and \( q^{\text{conv}} \) are the heat flow rates due to conduction and convection, respectively. \( q^{\text{stored}} \) denotes the net change of stored energy. The most general form of Eq. (4.1) can be written as

\[
q^{\text{heating}}_{m,n} + q^{\text{cond}}_{m-1,n} + q^{\text{cond}}_{m+1,n} + q^{\text{cond}}_{m,n+1} + q^{\text{cond}}_{m,n-1} + q^{\text{conv}}_{m,n} = q^{\text{stored}}_{m,n},
\]

(4.2)

considering the heat conduction between all neighboring nodes.
Using the explicit-form FDM modeling, the heat equation becomes [103]

\[ q_{m,n} \Delta x \Delta y \Delta z + k^{\text{left}} \Delta y \Delta z \left( \frac{T_{m-1,n}^i - T_{m,n}^i}{\Delta x} \right) + k^{\text{right}} \Delta y \Delta z \left( \frac{T_{m+1,n}^i - T_{m,n}^i}{\Delta x} \right) \]
\[ + k^{\text{up}} \Delta x \Delta z \left( \frac{T_{m,n+1}^i - T_{m,n}^i}{\Delta y} \right) + k^{\text{down}} \Delta x \Delta z \left( \frac{T_{m,n-1}^i - T_{m,n}^i}{\Delta y} \right) \]
\[ + h_{m,n} (T_0 - T_{m,n}^i) \Delta x \Delta y = \rho c \Delta x \Delta y \Delta z \left( \frac{T_{m,n}^{i+1} - T_{m,n}^i}{\Delta t} \right), \] (4.3)

where \( q_{\text{laser}} \) is the absorbed laser heat density, \( k \) is the thermal conduction coefficient, \( T \) is the temperature, \( c \) is the specific heat, \( \rho \) is the density and \( h \) is the convection coefficient. \( \Delta x, \Delta y, \Delta z \) are the dimensional increments in rectangular coordinate system. In Eq. (4.3), the superscripts of \( T \) denote the time increment. Using Eq. (4.3), the update equation for the nodal point \( m,n \) can be derived as

\[ T_{m,n}^{i+1} = T_{m,n}^i + q_{m,n} \Delta t \rho c + \frac{k^{\text{left}} (T_{m-1,n}^i - T_{m,n}^i) \Delta t}{\rho c (\Delta x)^2} + \frac{k^{\text{right}} (T_{m+1,n}^i - T_{m,n}^i) \Delta t}{\rho c (\Delta x)^2} \]
\[ + \frac{k^{\text{up}} (T_{m,n+1}^i - T_{m,n}^i) \Delta t}{\rho c (\Delta y)^2} + \frac{k^{\text{down}} (T_{m,n-1}^i - T_{m,n}^i) \Delta t}{\rho c (\Delta y)^2} + \frac{h_{m,n} (T_0 - T_{m,n}^i) \Delta t}{\rho c \Delta z}. \] (4.4)

The set of update equations for all nodes was solved with isolation boundary conditions. The temperature at the fixed end of the arm was kept constant at 300 K. The thermal conductivities and heat convection coefficients for the nodes were entered as matrices. For the edge of the structure, convection occurs from three surfaces, top, bottom and side; whereas for internal nodal points convection occurs from top and bottom surfaces. Multiplying each element of the heat convection coefficient matrix by a weight factor (3 for nodal points at the edge and 2 for internal nodal points), the heat convection difference at the edges was also taken into account. As seen in Eq. (4.4), the explicit-form FDM approach resulted in uncoupled update equations that can be easily solved with matrix operations. However, care should be taken when determining the time increments (\( \Delta t \)) to ensure stable solutions. The stability condition for 2D heat transfer is

\[ \frac{\kappa \Delta t}{(\Delta x)^2} \leq 0.25, \] (4.5)

where \( \kappa \) is the thermal diffusivity. Selecting \( \Delta t \) as \( 5 \times 10^{-5} \) s resulted in a stable solution for the system parameters specified in Table 4.1. The corresponding heat distribution for this model is shown in Figure 4.4.
Figure 4.4: Temperature distribution of the microactuator obtained by finite difference modeling. The FDM parameters are given in Table 4.1. The distance between each nodal point is 5 µm.

As expected, the temperature reaches the maximum (396 K) at the center of the disc and decreases along the arm. The temperature profile along the arm appears to be monotonically decreasing from 370 to 300 K.

For verification purposes, the same temperature distribution model was solved using ANSYS. The simulated temperature profile is illustrated in Figure 4.5. In order to compare both results, the temperature distribution obtained by finite difference model and ANSYS simulation are plotted along the horizontal line passing from the center of the arm. As seen in Figure 4.6, the results are in good agreement with a difference of approximately 5 K in the maximum temperature. The FDM discretization error can be the source of the discrepancy that can be minimized further by using finer mesh sizes (smaller than $5 \times 5 \mu m^2$) at the expense of longer computation times.
Figure 4.5: Temperature distribution of the microactuator obtained by finite element modeling using ANSYS.

Figure 4.6: Temperature distribution of the microactuator along the center-line of the arm obtained by finite difference model (FDM) and ANSYS. The distance between each nodal point is 5 µm.
4.2.2 Thermo-mechanical Analysis

Once the temperature distribution is determined, the tip displacement can be calculated using linear thermal expansion of the arms, disc and finger. The symmetric arms expand in a way that pushes the tip along its vertical axis as shown in Figure 4.7. This displacement can be calculated by modeling the arm as a fixed-guided beam. The guided end can move along y-axis due to symmetry of the two arms. In Figure 4.7, the guided end is replaced by a free end with a reactive force \( F_x \) and a reactive moment \( M_z \). The thermal heating causes elongation of the arm that is modeled as an axial force, \( F_a \) (Figure 4.7). This system is statically indeterminate with a degree of indeterminacy of two.

The boundary conditions at the guided end provide the required equations for the analytical solution. The x-displacement, \( u_x \), and rotation around the z-axis, \( \Theta_z \), are both zero at the guided end [101]. In mathematical terms,

\[
\begin{align*}
  u_x &= 0 \quad \text{and} \quad \Theta_z = 0. \quad (4.6)
\end{align*}
\]

Then applying Castigliano’s displacement theorem [101], the following equations are obtained

\[
\begin{align*}
  u_x &= \frac{\partial U}{\partial F_x} = \frac{\cos(\theta)L_1(F_x \cos(\theta) - F_a)}{EA} + \frac{\sin(\theta)L_1^2(3M_z + 2F_x \sin(\theta)L_1)}{6EI} = 0, \\
  \Theta_z &= \frac{\partial U}{\partial M_z} = \frac{2M_zL_1 + F_x \sin(\theta)L_1^2}{2EI} = 0, \quad (4.7)
\end{align*}
\]

where \( U \) is the total strain energy, \( \theta \) is the beam angle, \( I \) is the moment of inertia, \( A \) is the cross-sectional area and \( E \) is Young’s modulus of SU-8. Using the above two equations, \( F_x \) and \( M_z \) can be expressed in terms of \( F_a \) and geometrical parameters of the actuator. Then, the y-displacement of the arm, \( u_y \), can be calculated by applying a virtual force, \( F_v \), in y-direction at the free end of the beam. The bending moment around z-axis, \( M_b \), and normal force, \( F_N \), can be written as

\[
\begin{align*}
  M_b &= M_z + F_x \sin(\theta)x' + F_v \cos(\theta)x' \quad (4.8) \\
  F_N &= F_a - F_x \cos(\theta) + F_v \sin(\theta). \quad (4.9)
\end{align*}
\]

It should be noted that \( x' \) is the unit vector along the axis of the beam as shown in Figure 4.7. The total strain for the beam under a bending moment and an axial force is given as

\[
U = \frac{1}{2} \int_{0}^{L_1} \left( \frac{F_N^2}{EA} + \frac{M_b^2}{EI} \right) \, dx'. \quad (4.10)
\]
Applying Castigliano’s theorem and setting the virtual force to zero \( F_v = 0 \) yields
\[
 u_y = \frac{\partial U}{\partial F_v} = \frac{L_1^3 \sin(\theta) F_a}{12 E I \cos^2(\theta) + E \sin^2(\theta) L_1^2 A}. \tag{4.11}
\]

The axial force due to heat increase can be found using Hooke’s law as
\[
 F_a = A \sigma = A E \epsilon = A E \frac{\Delta L_1}{L_1}, \tag{4.12}
\]
where \( \sigma, \epsilon \) are the stress and strain, respectively. The change in length is calculated by the temperature profile derived in Section 4.2.1 as following
\[
 \Delta L_1 = \alpha \int_0^{L_1} (T(x') - T_0) \, dx', \tag{4.13}
\]
where \( \alpha \) is the coefficient of thermal expansion and \( T_0 \) is the initial temperature (300 K). Substituting Eqs. (4.12)-(4.13) into Eq. (4.11) yields
\[
 u_y = \frac{\alpha L_1^2 \sin(\theta) A \int_0^{L_1} (T(x') - T_0) \, dx'}{12 I \cos^2(\theta) + \sin^2(\theta) L_1^2 A}. \tag{4.14}
\]

In order to find the total tip displacement, \( u_{\text{tip}} \), the thermal expansion of the disc and the finger should be taken into account as well
\[
 u_{\text{tip}} = u_y + u_{\text{finger}} + u_{\text{disc}}. \tag{4.15}
\]
Assuming the heated disc has a uniform temperature, the final equation for the tip displacement can be obtained as
\[
 u_y = \frac{\alpha L_1^2 \sin(\theta) A \int_0^{L_1} (T(x') - T_0) \, dx'}{12 I \cos^2(\theta) + \sin^2(\theta) L_1^2 A} + \alpha \int_0^{L_2} (T_{\text{tip}}(y) - T_0) \, dy + \alpha r \Delta T. \tag{4.16}
\]
The $u_y$ term in Eq. (4.15) is more dominant than $u_{\text{finger}}$ and $u_{\text{disc}}$ since the arm length is much larger than the disc radius and finger length. From Eq. (4.16), it can be seen that thickness of the actuator does not have an affect on the displacement ($A = w \times t$, $I = w^3t/12$). Also, larger arm length, smaller arm width and smaller bending angle result in larger tip displacements.

4.3 Microgripper Design

The proposed polymeric microgrippers use the photo-thermal actuation explained in the previous section together with the SU-8 structural layer. The elimination of an additional actuation layer and the ease of processing of SU-8 give great flexibility in the design of the gripper. The fingers and flexures can be realized in various shapes and dimensions. Optimizing the geometrical parameters according to the design requirements is of paramount importance for the proposed microgrippers. Although various microgrippers have been produced as prototypes by the scientific community, there are only a few companies on the market producing commercial microgrippers [104–107]. Obtaining reliable operation while maximizing the tip deflection and force is a challenging task. Therefore, there are great demands for efficient and reliable microgrippers as a manipulation tool.

The most important design constraints of microgrippers are the deflection of the fingers, gripping force, time response and repeatability. In this section, four photo-thermally actuated microgripper designs were demonstrated. The microgrippers were compared in terms of these design parameters in the following sections using finite element modeling and experiments. A detailed discussion of each design parameter is presented. This thorough analysis can be applied to microgrippers operated with other actuation mechanisms, as well.

Four types of photo-thermal microgrippers were designed as shown in Figure 4.8. These designs have some common characteristics. All of these microgrippers have a monolithic structure with compliant parts. They are suspended in air at the edge of a large base region (the base is not shown in Figure 4.8). The laser beam is focused on the center of the circular region for heating the structure. All of the four microgrippers have one degree-of-freedom and operate in a normally closed configuration which means, when there is no laser irradiation, the fingers remain
in the closed position. During gripping or releasing, the laser is turned on and elongation of the arms, due to thermal expansion, moves the gripping arms apart that in turn open the fingers.

To be able to compare the performance of the four microgrippers, certain geometrical parameters were fixed for all designs. The length and the thickness of microgrippers were taken as 1000 µm and 50 µm, respectively. The initial finger opening was set to be 20 µm. The disc region has a radius of 75 µm. Each of the four designs is discussed below.

Figure 4.8: 2D schematic view of the microgripper designs.
4.3.1 Design I (d-I)

This design is based on the microgripper reported by Choi et al [81]. They have used a perturbation-based configuration design methodology to realize a SU-8 microgripper with PZT actuation. They have optimized the geometrical shape of the actuator using this method. The overall length and the width of the microgripper were 2 mm and 0.3 mm, respectively. Since photo-thermal actuation is employed in this study, the fixed end of the design was modified to have bent-beam arms demonstrated in Section 4.2. The rest of the design was kept the same. The length of the bent-arms is 400 µm with a bending angle of 6°.

4.3.2 Design II (d-II)

The second design (d-II) is a simplified version of d-I. The lateral movement of the circular region is still achieved by bent-arms as in d-I. However, the gripping fingers are placed at an angle and connected to the circular region with just one arm. It should be noted that bent-beam actuators give more deflection when the arm length is increased. Using inclined gripping arms allows one to use longer bent-beams for this design. Similar to d-I, the length of the bent-arms is taken as 400 µm and the bending angle is set as 6°.

4.3.3 Design III (d-III)

This is a slightly modified version of d-II. Laser heating causes thermal expansion and elongation in all arms. The elongation of gripping arms in d-II decreases the gap between gripper ends, therefore opposes the opening motion. In order to prevent this behavior, the gripper arms are modified to be straight as shown in Figure 4.8. Although the elongation of the arms at finger tips can generate a closing, it is negligible due to very low temperature increase at those regions. The bent-beam arms of d-III have the same dimensions and bending angle as in d-II.

4.3.4 Design IV (d-IV)

In the final design, the bent-arms are replaced with a single arm connecting the disk region to the base. This design can not be applied to electro-thermal actuators
because they require at least two connections to the base as they require a current flow. However, photo-thermal actuation removes this stringent condition. The lateral movement of the disc can be achieved by heating of a single arm using laser heat absorption. The gripping arms are connected to the disc by single arms as in d-II. It should be noted that since bent-beam arms are not used, the width of this design is much smaller compared to the first three designs.

4.4 Simulation and Fabrication of Microgrippers

Before proceeding with the fabrication, the operation of the microgrippers are verified using finite element simulations. Finite element modeling is crucial for the presented microgrippers in order to estimate the required laser power for the desired operation range of the microgrippers. Additionally, it is very challenging to obtain the experimental heat distribution along the microgrippers during operation. However, simulations can provide the temperature distribution and the corresponding mechanical deflection. By simply comparing the experimentally measured deflection values with the simulated ones, the temperature profile during the experiments can be estimated. This step is especially important when working with polymers (SU-8 in this work) which have low melting temperatures or glass-transition temperatures.

Finite element simulations of the microgrippers were performed using ANSYS. A sample ANSYS script is given in Appendix D. The 3D models of all designs were established to take into account complex 3D heat transfer mechanisms. The sequential modeling approach was followed to simulate the photo-thermal heating and the resultant deflection. First, the temperature distribution analysis was performed when a laser beam is absorbed by the microgripper. Then the structural analysis was performed to determine the motion of the microgripper. Two separate ANSYS physics environments were defined for these two analyses with different boundary conditions since motion of the microgripper does not affect the temperature distribution. The built-in 3D solid model elements of SOLID90 and SOLID95 were used for the temperature and structural environments, respectively. The material properties used in the simulations are listed in Table 4.2.

In the temperature analysis, laser heating was simulated with an input heat
Table 4.2: Material properties of SU-8 [108] and simulation parameters

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Specific heat (c)</td>
<td>1500</td>
<td>J/kg/K</td>
</tr>
<tr>
<td>Coefficient of thermal expansion (α)</td>
<td>52</td>
<td>ppm/K</td>
</tr>
<tr>
<td>Thermal conduction coefficient (k)</td>
<td>0.2</td>
<td>W/m/K</td>
</tr>
<tr>
<td>Convection coefficient (h)</td>
<td>10</td>
<td>W/m²/K</td>
</tr>
<tr>
<td>Initial temperature (T₀)</td>
<td>300</td>
<td>K</td>
</tr>
<tr>
<td>Volume laser heat density (qabsorbed)</td>
<td>350-500e6</td>
<td>W/m³</td>
</tr>
<tr>
<td>Young’s modulus (E)</td>
<td>4</td>
<td>GPa</td>
</tr>
<tr>
<td>Poisson’s ratio (ν)</td>
<td>0.22</td>
<td>-</td>
</tr>
<tr>
<td>Yield strength (σ_y)</td>
<td>60-73</td>
<td>MPa</td>
</tr>
</tbody>
</table>

flux on one side of the circular region. Considering the large heat capacity of the base due to its large size, temperature was kept constant at 300 K at the base connection surfaces. A heat convection loss was defined for all surfaces while radiation heat losses from the surfaces of the device were neglected due to relatively low operation temperatures (less than 500 K) compared to silicon microgrippers. Temperature-dependent material properties were not considered for the same reason. The results of the temperature analysis were used as inputs for the structural analysis. For the structural modeling, only one boundary condition was defined. The base connection surfaces were fixed with zero displacement. The structural analysis allowed the thermal expansion and deflection of the microgripper to be calculated based on the temperature profile obtained from the temperature environment. Both environments employ the same meshing that used approximately 16 000 - 20 000 elements. A static solution was performed except the time response simulations where a full-method transient solution was used. In transient solution, the time step was set to be 0.01 s.

The microgrippers were fabricated using conventional photolithography techniques as summarized below:

- First, SU-8 2075 (MicroChem Corp.) was spin-coated on a 4-inch silicon wafer (Montco silicon Technologies p-type [100]) at a coating speed of 1800 rpm.
• The coated 50 µm-thick SU-8 layer was then soft baked at 65°C for 5 min and then 95°C for 15 min.

• The features were defined with UV-exposure at 800 mJ/cm² through a single transparency mask. At the mask design step, the sharp corners of the designs were rounded by fillets to minimize the induced stress and reduce the risk of crack initiation. The transparency mask used for d-II is shown in Appendix E.

• The exposed SU-8 was hard baked at 65°C for 4 min and then at 95°C for 10 min.

• The structures were ramped cooled down to room temperature

• The features were developed in SU-8 developer for 12 min.

• The microgrippers were released off the chip in a 40% KOH solution and rinsed in DI (deionized) water.

Optical micrographs of the fabricated designs are shown in Figure 4.9. The microgrippers are suspended at the edge of the base.

4.5 Experimental Setup and Verification of the Actuation Model

The microgrippers have been characterized using an inverted microscope (Olympus GX 71) with a CCD camera. It is worth mentioning that photo-thermal actuation is a non-contact actuation mechanism. Therefore, there is no need to place the microgrippers on a probe station or a wire-bonded chip for the operation as done in most other actuation schemes. The photo-thermal microgrippers can be operated in an off-chip manner, which is practically useful. The experimental setup is schematically illustrated in Figure 4.10.

During experiments, the microgripper was placed on the x-y stage of the inverted microscope. A 5.6 mm diameter 200 mW laser diode was used for laser radiation. The laser has a peak wavelength of 635 nm. The laser diode was connected to a voltage source that supplied a pulsed waveform. The laser beam spot size was reduced down to 50 µm-radius using a collimating lens and a focusing lens as shown
Figure 4.9: Top view of fabricated SU-8 microgrippers with closed fingers.

Figure 4.10: 2D schematic view of the experimental setup.
in Figure 4.10. The laser diode and the lenses were placed on a z-stage to finely tune the laser focusing. By changing the height of the stage, the distance between the focusing lens and the microgripper was varied and the spot size was finely adjusted. A picture of the experimental setup is given in Figure 4.11.

When the power of the laser beam was measured using a powermeter (LaserCheck Coherent), it was observed that 3/4 of the beam power is lost through the optics until the beam reaches the microgripper. Therefore, the initial 200 mW laser beam provides an incident beam of 50 mW. SU-8 is transparent to the laser beam at 635 nm wavelength. To increase the laser absorption for more heating, the circular region of the microgrippers were dyed with black ink using a microprobe before the experiments. The laser absorbance of the dyed microgripper was measured with the powermeter and it was observed that 1% of the incident beam was absorbed by the gripper. Since most of the focused laser beam was transmitted through the gripper, a short-pass filter with a cut-off frequency of 550 nm was placed underneath the x-y stage. In this arrangement, the objective of the inverted microscope was protected during the experiments. Optical absorbance of SU-8 is higher for low wavelength beams [109]. Therefore, the dying process can be eliminated by using an optical beam with a lower wavelength. However, a visible-range beam of 635 nm wavelength was preferred for the ease of alignment and observation during the experiments. The motion of the grippers was recorded at 10 fps using image analysis software. Using the captured images, the position of the tips was measured to calculate the tip deflection and the time response was measured as well. The
force at the tip was not measured experimentally, therefore the discussion about the gripping force was based on finite element modeling. For the repeatability tests, a square wave signal was used for actuation.

All of the analysis in this chapter is done for microgrippers operated in air. For the biomanipulation applications in aqueous solutions, it is worth noting that only the tip of the microgripper should be dipped into the solution in a tilted manner [81]. Keeping the body part of the microgripper out of the solution would be a good practice to avoid overheating of the solution and for precise laser focusing for actuation.

It should be noted that the dimensions of the microgrippers can be varied according to the size of the objects to be gripped. Figure 4.12 shows many different sizes of microgrippers fabricated in a single batch. The photo-thermal microactuator model developed in Section 4.2, was tested by fabricating several configurations of actuators using the same steps explained above. Bent-beam microactuators were fabricated with various arm lengths, widths and bending angles and characterized using the inverted microscope. The tip motion was measured to test the effect of changing arm parameters (length, width and angle). In the first set, the microactuators vary in terms of the arm length (from 750 µm to 1100 µm) whereas the width and angle were kept constant at 50 µm and 6°, respectively.

The measured tip motion is plotted in Figure 4.13 together with the results of the analytical model and simulations. For the model and the simulations, 0.5 mW of input heating power was applied while observing the tip deflection for various geometries. The effects of arm width and bending angle were similarly tested and the results are plotted in Figure 4.14 and Figure 4.15, respectively. Using these three plots, it can be observed that larger tip displacement can be obtained with increasing arm length and decreasing arm width and bending angle as Eq. (4.14) suggested. It can be seen that the experimental results are in good agreement with the analytical model. It is worth mentioning that the maximum uncertainty for the tip displacement measurements was calculated as 2.48 µm in ten repetitive measurements. The highest mismatch between the experiments and the model is observed for microactuators with an arm length of larger than 1000 µm (Figure 4.13). This can be attributed to the fact that increasing arm length might generate some undesired out-of-plane displacement of the arms that is taken as zero during the derivation of the analytical model. Therefore, the difference be-
Figure 4.12: The fabricated SU-8 microgrippers of various sizes.

Figure 4.13: Dependence of the tip displacement on arm length plotted for analytical, simulation and experimental results ($w_1=50\ \mu m$, $\theta=6^o$).
Figure 4.14: Dependence of the tip displacement on arm width plotted for analytical, simulation and experimental results ($L_1=700 \, \mu\text{m}, \theta=6^\circ$).

Figure 4.15: Dependence of the tip displacement on bending angle plotted for analytical, simulation and experimental results ($L_1=1000 \, \mu\text{m}, w_1=50 \, \mu\text{m}$).
tween the experimental and calculated tip displacements increases in Figure 4.13 as the arm length increases.

4.6 Characterization of Microgrippers

Characterization is critical to maximize the application-specific performance, however, it was not paid full attention in most of the published studies [81, 110]. In this section, a thorough evaluation of the proposed microgrippers is provided in terms of four gripper parameters: finger deflection, gripping force, time response and repeatability, as discussed in detail below.

4.6.1 Finger Deflection

The amount of deflection at the tip of the fingers is one of the most important design constraints since it determines the size of the object that can be handled by the microgripper.

It is intuitive that as the laser power is increased, the temperature and thermal expansion increase that yields higher finger deflections. However, it should be noticed that there is a maximum temperature limit for repeatable operation of SU-8 devices. If the glass-transition temperature of SU-8 (around 210°C) is exceeded, the structure softens and fails to keep its original shape. For repeatable operation, the maximum temperature should be kept below this limit. In numerical analysis, the maximum allowed temperature was kept as 90% of the glass-transition temperature (i.e. 189°C). During the experiments, the incident laser power was increased gradually until plastic deformation was observed. The absorbed laser heat power required that causes plastic deformation can be predicted by the finite element simulations. For all microgrippers, the laser diode input voltage at the instance of plastic deformation was recorded. It was observed that all microgrippers operate repetitively without any plastic deformation when the laser input voltage was kept below 3 V. The temperature distribution along the microgrippers was not measured experimentally, but it was predicted using the simulation results. The link between the simulations and the experiments was established through the finger displacement measurements which can be measured both experimentally and numerically.
Figure 4.16: Top view of finite element model simulations of the deflected model (left) and temperature distribution (right) along the microgrippers using ANSYS.
However, first the finite element simulations should be verified. This was achieved by using the glass-transition temperature. The laser power was increased while noting down the laser diode voltage until the structures are plastically deformed. At the instance of plastic deformation, the finger deflection value was compared with the simulations run at the plastic deformation limit (210°C). This comparison verified the finite element simulations which allowed the prediction of experimental temperature values through simulations. During the experiments, the deflection of the fingers was continuously monitored and compared with the simulations which also give the temperature distribution.

Figure 4.16 demonstrates the ANSYS simulation results when each of the four microgrippers was simulated at its maximum operating temperature of approximately 462 K (189°C). The input laser powers used under this condition were 520 µW, 512 µW, 505 µW and 425 µW for d-I, d-II, d-III and d-IV, respectively. These ANSYS results are extremely important to determine the microgripper that achieves the maximum deflection within the allowed temperature range because the temperature profile was not observed through experiments. Figure 4.16 illustrates the temperature profile (shown on the right) and the corresponding deformed structure (left) with an inset zooming the gripping finger tips. It can be seen that the finger deflections are 3.7 µm, 28.6 µm, 29.3 µm and 6.4 µm for d-I, d-II, d-III and d-IV, respectively. D-III can achieve the largest deflection when the microgrippers are operated at the same maximum temperature condition. The finger opening of d-III can be increased from 20 µm to 78.6 µm if 505 µW of laser power was absorbed.

The finger deflections were also measured experimentally. Figure 4.17 shows the optical micrographs of the grippers at steady state when 2.8 V was applied to the laser diode which corresponded to approximately 500 µW of absorbed heat power. For a comparison of all the polymeric photo-thermal microgrippers, Figure 4.18 plots the finger deflection as a function of incident laser power with error margins for five measurements. The laser diode input voltage was varied between 2.3 V and 3 V with 0.1 V increments while measuring the power of the focused beam (incident beam) and the finger deflection. It was observed that the laser power increases linearly with the increasing input voltage. The power measurements have an uncertainty of approximately 5% due to the device limitations and the incident angle of the beam during the measurements. It is seen that d-III yields the highest
deflection whereas d-I gives the minimum deflection for all input voltage values.

4.6.2 Gripping Force

The amount of force applied by the gripping fingers to the object should be known and precisely controlled for some critical applications of microgrippers such as biomanipulation. In fact, gripping force is a function of the finger deflection. Similar to springs, the larger the gripping arm deflection, the higher the retracting force. Therefore, it is hard to interpret the results that mention the gripping force without reporting the deflection.

For a thorough analysis of gripping force, each gripping arm has been modeled
The absorption of dyed SU-8 is around 1% as a spring where its spring constant was determined using ANSYS simulations. In these simulations, only structural environment was defined as explained in Section 4.4.

To open the fingers, an external force, $F_{grip}$, was perpendicularly applied to the surfaces which get in contact with the gripped object. The resultant tip displacement in the direction of the force was noted while varying the gripping force ($F_{grip}$). The recorded results for d-I were plotted in Figure 4.19, as circles. Then a least-square linear regression fitting model was applied to find the linear relationship between the tip deflection ($\mu$m) and force ($\mu$N). The linear fitted line is shown in Figure 4.19, as well. The reciprocal of the slope of this line gives the spring constant, $k_{arm}$, for the gripping arm. A similar procedure was followed for all designs and the results were summarized in Table 4.3. The maximum gripping force, $F_{max}$, was found by multiplying the spring constant, $k_{arm}$, with the maximum displacement, $d_{max}$, numerically calculated in Section 4.6.1. The force resolution was calculated using the spring constant and experimental finger deflection values. From Figure 4.18 it can be seen that the finger deflection is proportional to the incident beam power and the laser input voltage. For each microgripper, this proportionality constant was calculated as 3.44 $\mu$m/V (d-I), 27.98 $\mu$m/V (d-II), 29
Table 4.3: The simulated gripping force values for all microgripper designs

<table>
<thead>
<tr>
<th></th>
<th>$k_{arm}$ (N/m)</th>
<th>$d_{max}$ (µm)</th>
<th>$F_{max}$ (µN)</th>
<th>Force res. (µN/V)</th>
</tr>
</thead>
<tbody>
<tr>
<td>d-I</td>
<td>33.4</td>
<td>3.7</td>
<td>123.6</td>
<td>114.9</td>
</tr>
<tr>
<td>d-II</td>
<td>5.03</td>
<td>28.6</td>
<td>143.9</td>
<td>140.7</td>
</tr>
<tr>
<td>d-III</td>
<td>4.33</td>
<td>29.3</td>
<td>126.9</td>
<td>125.6</td>
</tr>
<tr>
<td>d-IV</td>
<td>4.24</td>
<td>6.4</td>
<td>27.1</td>
<td>31.7</td>
</tr>
</tbody>
</table>

$\mu$m/V (d-III), 7.48 $\mu$m/V (d-IV). Multiplying these values with the spring constant gives the force resolution as listed in Table 4.3.

D-IV has a force resolution of 31.7 $\mu$N/V. Therefore, when voltage is varied by 0.01 V increments, the force can be adjusted with a resolution of 0.3 $\mu$N. This allows fine-adjustment of force which is especially crucial for handling of delicate objects [111].

It is also possible to find the spring constant of the arms experimentally using atomic force microscope (AFM). The interested readers can refer to [112] where the spring constant of cantilever beams are determined using AFM.

### 4.6.3 Time Response

The time response of polymeric photo-thermally actuated microgrippers was studied using finite element simulations and through experiments. In this study, the response time of the microgrippers is specified as the time to raise the finger deflection to 90% of its final value when a step load is applied [113]. Transient-solution simulations of the microgrippers were performed with 0.01 s time steps. The deflection of the fingers is plotted as a function of time for d-I at 520 $\mu$W of input laser power in Figure 4.20. The response time of d-I was measured as 1.93 s from this plot. FEM simulations have shown that for the other designs, similar values were obtained. D-II, d-III and d-IV have response times of 1.42 s, 1.41 s and 1.06 s, respectively.

It is seen that the response of polymer microgrippers are very slow. Since the experimental setup used in this study was capable of recording the microgripper’s deflection at 10 fps, the response times were measured experimentally as well.
Figure 4.19: The simulation results of finger deflection of d-I as a function of gripping force used to calculate the spring constant.

slope = \frac{1}{k} = 0.516

Figure 4.20: The simulation results of finger deflection as a function of time used to calculate the response time.
Table 4.4: The experimental values of opening and closing time together with maximum operating frequency for all the designs

<table>
<thead>
<tr>
<th></th>
<th>$t_{\text{opening}}$ (s)</th>
<th>$t_{\text{closing}}$ (s)</th>
<th>max. operating freq. (Hz)</th>
</tr>
</thead>
<tbody>
<tr>
<td>d-I</td>
<td>1.8</td>
<td>0.7</td>
<td>0.4</td>
</tr>
<tr>
<td>d-II</td>
<td>1.4</td>
<td>0.6</td>
<td>0.5</td>
</tr>
<tr>
<td>d-III</td>
<td>1.3</td>
<td>0.7</td>
<td>0.5</td>
</tr>
<tr>
<td>d-IV</td>
<td>1.1</td>
<td>0.6</td>
<td>0.59</td>
</tr>
</tbody>
</table>

recorded movies of the operating grippers allow the measurements with a resolution of 0.1 s. For d-I, it was observed that the opening of the fingers was completed in 1.8 s after the laser was turned on. During closing, steady-state was reached at approximately 0.7 s. Then, one opening-closing cycle of d-I can be found as 2.5 s that gives a maximum operating frequency of 0.4 Hz (1/2.5). The results of experimental measurements of response time for all designs are listed in Table 4.4.

The four designs are similar in terms of their response time which is around 2 s for one complete cycle. One drawback of using SU-8 as an actuation layer is the high response time due to low thermal conductivity ($k=0.2$ W/m/K for SU-8, whereas $k=30$ W/m/K for polySi). On the other hand, this may not be a limitation for the applications proposed for these microgrippers such as biomanipulation where the required motion is slow. Kim et al. stated that generally the operating frequency of such microgrippers varies between 0.1 Hz and 10 Hz [114]. The maximum operating frequency values listed in Table 4.4 are in this region.

### 4.6.4 Repeatability

For repeatable operation of the microgrippers, plastic deformation should be avoided. Therefore, maximum stress should be kept less than the yield strength. The deflection induced stress is calculated by simulations for all designs. The von Mises stress results are shown in Figure 4.21 with insets focusing the highly stressed regions. The microgrippers were driven to the maximum allowed temperature limit of 462 K. The maximum von Mises stress values were simulated as 31.2 MPa, 27.3 MPa, 27.5 MPa, 4.8 MPa for d-I, d-II, d-III and d-IV, respectively. These values are well below the yield strength of SU-8 (60 MPa) which ensures that the grippers
Table 4.5: Overall performance of polymeric photo-thermal microgrippers

<table>
<thead>
<tr>
<th></th>
<th>Defl. (µm)</th>
<th>$F_{\text{max}}$ (µN)</th>
<th>Resp. time (s)</th>
<th>Repeatability</th>
<th>Application</th>
</tr>
</thead>
<tbody>
<tr>
<td>d-I</td>
<td>3.7</td>
<td>123.6</td>
<td>1.8</td>
<td>good</td>
<td>biomanipulation</td>
</tr>
<tr>
<td>d-II</td>
<td>28.6</td>
<td>143.9</td>
<td>1.4</td>
<td>good</td>
<td>microsurgery</td>
</tr>
<tr>
<td>d-III</td>
<td>29.3</td>
<td>126.9</td>
<td>1.3</td>
<td>good</td>
<td>microsurgery</td>
</tr>
<tr>
<td>d-IV</td>
<td>6.4</td>
<td>27.1</td>
<td>1.1</td>
<td>excellent</td>
<td>microassembly</td>
</tr>
</tbody>
</table>

are operated in the elastic deformation regime. The reliability of the microgrippers was also tested experimentally since the actual material constants might be affected by the operating conditions, temperature in particular. Considering the maximum operating temperature of the grippers derived in Section 4.6.1, the grippers were actuated at 80% of their maximum displacement for 10 h using a 0.3 Hz square wave with 40% duty cycle. This corresponds to 1080 cycles in an hour. When the deflection of the grippers was investigated after completing more than $10^4$ cycles, no degradation or plastic deformation was observed. It can be attributed to the fact that the sharp corners that induce the maximum stress are rounded in the fabricated designs. The insets of Figure 4.9(b) demonstrate the rounded corners that minimize the induced stress to allow repeatable operation.

4.6.5 Overall performance of photo-thermal microgrippers

The overall performance of all four microgrippers is summarized in Table 4.5 together with possible fields of application. It was observed that d-II and d-III outperform in finger deflection. The modified gripping arms of d-III allow it to have slightly higher deflections than d-II. However, the difference is not very high that can be explained by the temperature profile results shown in Figure 4.16. The temperature at the modified region of the gripping fingers is around 330 K. Therefore, there is little thermal expansion at these regions. If these two designs are compared using electro-thermally actuated silicon or metal microgrippers higher differences in deflection can be observed due to higher temperatures reached. When the temperature distribution of the grippers is observed (Figure 4.16), it can be seen that d-I has the lowest temperature at the tip of the fingers, thus provides the safest handling and more applicable to biomanipulation experiments.
In terms of gripping force, d-II provides the highest value which is 143.9 $\mu$N. Although d-IV has the lowest $F_{\text{max}}$ value, it provides the highest force resolution as 31.7 $\mu$N/V (Table 4.3), therefore allows the finest control of force compared to other designs.

When response time of the grippers are compared, it is seen that d-IV is the fastest with 1.1 s whereas d-I is the slowest microgripper with a response time of 1.8 s. The reason for these high response time values is the low thermal conductivity of SU-8. D-IV has the fastest response because instead of long chevron-arms, it uses a shorter arm to connect the laser focusing region to the base. Therefore, heat can be transferred to the base in less amount of time and steady-state is reached faster.
For microassembly applications where speed might be an important constraint, d-IV would yield better results.

All of the four designs proved to be reliable in $10^4$ cycles of operation. However, the difference between the maximum von Mises stress values should be pointed out for comparison. Figure 4.21 demonstrates that the maximum stress value of d-IV (4.8 MPa) is five times smaller than the first three designs. Therefore, one can conclude that d-IV would minimize the probability of observing fatigue in the long run.

It should be noted that the values in Table 4.5 were obtained when the microgrippers were driven to 90% of the maximum allowed temperature limit. It is observed that d-I, d-II and d-III approach the yield strength limit, whereas d-IV stays well below the plastic deformation threshold (Figure 4.21). Thus, the main limiting factor for d-IV is the temperature. If this design is applied to silicon or metal microgrippers where stress is the main limiting factor, the deflection and maximum force values of d-IV can be improved by increasing the operation temperature.

In this section, the thickness, length or width of the designs were kept constant to compare the four designs. However after selecting one of these microgrippers depending on the application, the performance can be further improved by tailoring the thickness, length or width of the beams. For instance, it is known that by increasing the length of bent-beam arms or reducing the bending angle, it is possible to increase the displacement of bent-beam arms that in turn increases the finger deflection [87].

It is also critical to evaluate the performance of SU-8 photo-thermal microgrippers in general compared to previously reported microgrippers. Molhave et al [68] and Kim et al [114] provide nice comparisons of electro-thermal, electro-static, piezo-electric and shape memory alloy (SMA) microgrippers. It is seen that polymeric photo-thermal microgrippers achieve similar deflections as the other microgrippers at the same size while keeping the operating temperate considerably low. This is a great asset of polymer microgrippers. On the other hand, the maximum gripping force of polymer microgripper is much lower compared to its counterparts. Metal microgrippers can provide gripping forces on the order of mN [114]. Although this can be considered as a limitation of polymer microgrippers used in microassembly applications, for biological applications the gripping forces of a few $\mu$N is enough
for handling of cells. Jericho et al reported a gripping force of 0.2 \( \mu N \) for successful manipulation of gram-positive S. aureus bacteria and stated that even smaller forces are required to handle gram-negative bacteria [111]. The time response of microgripper is generally not studied in the reported literature. However, comparing electro-thermal, electro-static, piezo-electric and SMA actuators with polymer photo-thermal actuators, it is apparent that polymeric photo-thermal actuators are very slow. Usually the speed of operation is not a concern for microgrippers as stated by Kim et al [114]. In fact, the slow operation of polymer microgrippers can be an advantage for biomanipulation tasks. Chronis et al have mentioned that one of the biggest hurdles of manipulation of samples in solution is the drag of fluid because of the motion of microgripper in the vicinity of the sample [78]. As a solution to this problem, they suggest moving the microgripper slowly when approaching the sample which is also experimentally verified. Therefore, the slow motion of the gripping fingers of polymer microgripper can be an advantage by minimizing the fluid drag force on the object of interest during the closing of the fingers.

Combining polymer materials with photo-thermal actuation brings unique advantages to the microgrippers designed for the magnetic levitation system. Due to non-contact photo-thermal actuation, the grippers can be operated on the fly, in an off-chip manner. For the magnetic levitation experiments provided in the following chapters, d-II and d-III were selected mainly because of their superior finger displacement results as given in Table 4.5.
Chapter 5

Magnetic Levitation of Microgrippers

As explained in the introduction section, magnetic levitation of microgrippers is achieved by attaching them to permanent magnets or magnetic thin films. In this way, the magnetic material and the end-effector tool can be designed independently. By simply changing the microgripper with another MEMS tool, the system can be used for various other applications.

In this chapter, first the controller of the magnetic levitation setup is discussed. The levitation performance of mm-size permanent magnets are improved using a setpoint ramping controller as demonstrated in Section 5.1. In Section 5.2, different microrobot configurations are shown using in-plane and out-of-plane magnetized samples. In Section 5.3 and Section 5.4, levitation of microgrippers are demonstrated using electrodeposited magnets and commercial magnets, respectively. Finally, Section 5.5 demonstrates the micromanipulation of tiny components such as optical fiber and electric wire. For all the experiments demonstrated in this section, eddy current damping explained in Section 2.5 is employed using a 5 mm thick, 5 cm radius cylinder plate as the launching pad for the microrobot.

5.1 Setpoint Ramping Controller

For the magnetic levitation experiments of levitating microrobots, four types of controllers were tested. These controllers were designed by E. Shameli [26]. They
Figure 5.1: Two permanent magnets snapped together: (a) schematic drawing, (b) picture.

can be listed as model-reference feed forward controller, feedback linearization controller, setpoint ramping controller and adaptive controller. For micromanipulation applications presented in this chapter, the mass of the levitated object is less than 5% of the weight of the microrobot, therefore the mass change can be neglected. This suggests that adaptive controller is not required for these experiments. The levitation performance of the first three controllers were tested using the magnets configuration shown in Figure 5.1. Two magnets are snapped to each other. The top magnet has an out-of-plane magnetization and the lower one has an in-plane magnetization. The alignment of the magnetic dipole moments make the magnets stable at the configuration shown in Figure 5.1.

The same trajectory composed of step and ramp input commands are given for all controllers and the results are shown in Figure 5.2. It can be seen that all of the controllers provide roughly the same positioning error which is around 14 \( \mu \text{m} \). Although feedback linearization and model reference feed forward controllers provide very small settling times, they both suffer from high over and undershoots. On the other hand, the setpoint ramping controller minimizes the over and undershoots since the command signal is fed to a path planning block as demonstrated in Figure 5.3.

It can be seen that there is a trade-off between the speed of the control and achieving small overshoots. For the levitation of the photo-thermal polymeric mi-
Figure 5.2: The controllers designed for magnetic levitation system: (a) Model reference feed-forward controller, (b) Feedback linearization controller, (c) Setpoint ramping controller
crogrippers, minimizing overshoots and undershoots is more important than the speed of the system. It is crucial to minimize the undershoots, because when the microrobot is moved down, the potential undershoot can cause the microgripper to hit surrounding objects or the platform underneath and either the gripper or the objects can be damaged. Since gentle handling is more important than speedy motion, the setpoint ramping controller (shown in Figure 5.3) was implemented for the experiments in this chapter. The path-planning block is a second order system with a transfer function as

$$G_{\text{path-planning}} = \frac{\omega_n^2}{s^2 + 2\xi\omega_n s + \omega_n^2} \quad (5.1)$$

where the natural frequency ($\omega_n$) and damping ratio ($\xi$) were optimized by E. Shameli as 5 rad/s and 1.05 [26].

### 5.2 Assembly of Levitating Microrobot

As explained in Section 2.3, the magnetic levitation setup presented in this dissertation generates a vertical magnetic field gradient. The magnetic dipole moment vector aligns itself with this gradient and determines the type of levitation: vertical or horizontal as shown in Figure 5.4. The in-plane and out-of-plane magnetized samples can be used together as shown in Figure 5.1.

Comparison of the microgripper designs presented in Section 4.6 revealed that gripper d-II and d-III achieve maximum deflection. Thus, these grippers are used to demonstrate the features of micromanipulation system. The objects to be manipulated are cylindrical samples with a diameter of 100 µm, 125 µm and 1 mm. Therefore, microgrippers are designed to have an initial opening of 80 µm and have
a size of 3 mm by 4 mm as shown in Figure 5.5. These grippers can achieve finger openings up to 300 µm.

The microgrippers were fabricated with rectangular base to be attached to the magnetic samples. Given the different levitating sample configurations and the stand-alone microgrippers, it can be seen that microrobots can be assembled in many different ways. Some of the possible combinations are shown in Figure 5.6 using the in-plane and out-of-plane magnetized samples. The microgripper can be attached to the magnetic samples (either electrodeposited thin film or commercial permanent magnet). The finite element simulations showing the magnetic flux density of each robot is shown in Appendix F.

From these configurations, (a) and (d) are not very practical since the micro-
grippers are located at the bottom. These two microrobots would be prone to damaging during launching and landing of the microrobot. Configuration (b) was not implemented because of the line laser position sensors. As shown in Figure 5.7, a vertically levitated design would have a limited x-motion range, because it may lose the sight of the vertical laser line due to its small width. Configuration (c) seems to get around with this problem by having a wider span on the horizontal plane, however it complicates the actuation of the gripper. Since the gripper is perpendicular to the vertical axis, the laser should be focused from the bottom or top for gripper actuation. However the laser optics can only be placed on the side of the working domain as shown in Figure 2.4. For these reasons, configuration (e) shown in Figure 5.6 was used for the levitating microgripper.

When an in-plane and out-of-plane magnetized sample were used together as shown in Figure 5.6(e), the mass of the magnetic portion of the microrobot is increased. Then, if the total weight of the microrobot is considered, the mass of the
microgripper and the levitated object can be neglected when the microrobot has a massive magnetized section. Therefore, this configuration is also expected to yield better results for the non-adaptive controller selected.

5.3 Levitation of Microgrippers using Electrodeposited Magnets

The levitation performance of the selected microrobot configuration was initially tested using the electrodeposited samples. An in-plane and out-of-plane magnetized sample were snapped together as shown in Figure 5.6(e). The magnetization direction of the samples holds these magnets together. The magnetic levitation setup is modified as explained in Section 3.4. The microgrippers are attached to the magnets using epoxy glue. A trajectory composed of step and ramp inputs was applied and the experimental position data is shown in Figure 5.8. It is seen that the electrodeposited samples can follow the trajectory in a motion range of 4 mm in the vertical direction. The rms positioning accuracy was measured as 34.3 $\mu$m.

The horizontal motion performance of the system was tested by moving the microrobot on a square trajectory with 4 mm side length ($x_{ctrl}$ and $y_{ctrl}$ are changed from -0.03 to 0.03 for this range). The recorded experimental position data is shown
in Figure 5.9. The positioning error during horizontal positioning was calculated as 212 µm from this plot.

5.4 Levitation of Microgrippers using Commercial Magnets

The same experiments presented in Section 5.3 were repeated using commercial NdFeB magnets instead of electrodeposited samples. The dimensions of the microrobot is shown in Figure 5.1. After attaching the microgripper, the weight of the microrobot was measured as 620 mg.

The experimental results of vertical and horizontal positioning are shown in Figure 5.10 and Figure 5.11, respectively. The rms positioning for the experimental data were measured as 13.2 µm for the vertical levitation experiments. It is seen that the levitated microgripper can successfully follow the given trajectory in a motion range of 4 mm. The under/overshoots are suppressed for both 2 mm and 4 mm step commands.

For the horizontal motion, it is seen that the microrobot can be positioned in a square motion range of 4 mm side length. For the given horizontal testing trajectory, the microrobot was held constant at the corners of the square for 10 s, before moving
Figure 5.9: Horizontal motion of microrobot with electrodeposited magnets: (a) Measured x position of microrobot with electrodeposited magnets, (b) Measured y position of microrobot with electrodeposited magnets, (c) Measured x-y trajectory of microrobot with electrodeposited magnets
Figure 5.10: Vertical motion of microrobot with permanent magnets.

to the next corner. The x and y recordings shown in Figures 5.11(a)(b) show that the positioning error is higher for the horizontal positioning compared to vertical precision. This can be attributed to the fact that the microrobot is composed of non-cylindrical magnets (square magnets as shown in Figure 5.1). Therefore, any spin of the microrobot around itself is sensed as a position change by the horizontal laser sensor.

Demonstrating the levitation experiments for the microrobots composed of electrodeposited magnets and commercial magnets, it is crucial to make a comparison between the two systems.

The microrobots using the electrodeposited thin films are much more cost effective. In a single batch using a 4-inch silicon wafer, hundreds of robots can be produced. In addition, the use of a MEMS-compatible deposition process allows the design of various levitating MEMS robots using different end-effector tools. After the MEMS robot is manufactured, it can be coated with the magnetic film as shown in Section 3.2 and can be levitated. On the other hand, the electrodeposited films have inferior magnetic properties compared to the commercial magnets. Stronger magnetic field should be generated by the magnetic drive unit, which requires higher currents applied to the electromagnets. This generates excessive heating of the electromagnet assembly and affects the system properties. Also, the positioning error is more than two times higher for the microrobots using electrodeposited thin films
Figure 5.11: Horizontal motion of microrobot with commercial magnets: (a) Measured x position of microrobot with commercial magnets, (b) Measured y position of microrobot with commercial magnets, (c) Measured x-y trajectory of microrobot with commercial magnets.
Table 5.1: The comparison of microrobots using different magnetic samples

<table>
<thead>
<tr>
<th>Microrobot with electrodeposited films</th>
<th>Microrobot with commercial magnets</th>
</tr>
</thead>
<tbody>
<tr>
<td>• MEMS compatible, integrated fabrication</td>
<td>• Higher positioning accuracy</td>
</tr>
<tr>
<td>• Low cost</td>
<td>• Operates in a larger air gap</td>
</tr>
<tr>
<td>Pros (+)</td>
<td>• Low current</td>
</tr>
<tr>
<td>• Does not require cooling</td>
<td>• Can be used for manipulation of magnetic objects</td>
</tr>
<tr>
<td>Cons (-)</td>
<td>• The size of the robot is limited</td>
</tr>
<tr>
<td>• Non-uniform magnetization values, so less precision</td>
<td>• Does not allow custom designed microrobots for specific applications</td>
</tr>
<tr>
<td>• Requires higher current, not power friendly</td>
<td></td>
</tr>
<tr>
<td>• Excessive heating, so requires cooling (limits operation time)</td>
<td></td>
</tr>
</tbody>
</table>

than the ones with commercial magnets. The comparison between the microrobots using electrodeposited thin films and commercial magnets is summarized in Table 5.1.

When the levitation performance of microrobots with commercial magnets is considered, it is first observed that precision is greatly improved. This can be explained by the uniform magnetization of the commercial permanent magnets. Another explanation for the higher precision is the removal of the permanent magnets in the upper yoke end of the drive unit. Therefore, the magnetic field is only generated by the electromagnets which is completely controlled by the controller. However, when permanent magnets are included in the loop to improve magnetic field density, the controller can only adjust the portion of the magnetic field that is controlled by the electromagnets. The use of powerful commercial magnets also required less current and revealed the problems with excessive heating. When the additional 8th electromagnet is removed, a larger air gap is obtained for the levitating microrobot. Another advantage of using commercial magnets is that the microrobot can be used for the manipulation of magnetic samples as well. The
levitation force is a function of the gradient of magnetic flux density as derived in Section 2.3. When powerful magnets are used, the required magnetic field gradient is smaller. Therefore, objects which have smaller magnetic dipole moments will not be levitated by the drive unit. In this way, the microrobot can be operated close to magnetic objects, as well. The downsides of the microrobot with commercial magnets is that the dimensions of the robot is determined by the sizes of the permanent magnets available in the market. Also, the flexibility in terms of the shape of the robot is very limited. Although custom designed magnets can be used, it substantially increases the cost of the robot. The attachment of the microrobot with the commercial magnet can also be an issue to be addressed if the size of the microrobot is further reduced.

5.5 Micromanipulation Experiments

In this section, the results of some micromanipulation experiments are demonstrated. In Section 5.4, it has been shown that the microrobot with commercial permanent magnets can achieve a positioning accuracy of 13.2 μm. This allows handling of micro objects such as optical fiber, electrical wire and cable strip as demonstrated in this section. The position of the levitated microrobot was controlled by the operator through visual feedback. The high magnification camera was used for real-time imaging of the robot and its surrounding. Movies were recorded during the operation of the microrobot. Sequential snapshots were taken from the recorded movies to demonstrate the gripping, lifting and pulling of some micro objects. All operations were operated on a surface with 1 cm × 1 cm grid lines to give a sense of the dimension to the readers.

First, the actuation of the microgripper fingers is shown in Figure 5.12. In the first image, the fingers are in closed position. When the laser is focused on the circular spot, the fingers are opened as shown in the second image. The laser spot is aligned with the microrobot using x-y microstages. The z-axis adjustment is done manually.

Figure 5.13 shows the manipulation of a 125 μm diameter fiber piece. First the microgripper approaches the fiber and the fingers are opened (a). Then, the fingers are closed and fiber is hold at the tip of the fingers (b). The microrobot is moved
Figure 5.12: Sequence of images demonstrating the operation of the levitating microgripper.

Figure 5.13: Sequence of images demonstrating the manipulation of optical fiber. While holding the fiber (c) and finally by opening the fingers, the fiber is released (d).

A similar type of manipulation was done for a large cable strip of 1 mm diameter by using d-III type microgripper. Since the object is large, this time the object is held by the longitudinal gripper arms instead of the tip of the fingers (Figure 5.14).
Similar to the manipulation of the fiber, the fingers are opened during the grasping and releasing of the cable strip. One end of the objects are always left on the stage, because it is hard to balance the weight of the object equally when the microgripper is attached vertically.

Different kinds of manipulation schemes are also tested such as lifting and pulling. An electrical wire with a diameter of 100 µm is positioned at the edge of a stage. Figure 5.15 shows the sequence of images during the lifting of the wire. The micro-robot first approaches to the wire from underneath and aligns its tip with the wire
Figure 5.15: Sequence of images demonstrating the microgripper lifting a piece of wire.

(a). Then, the wire is carried by the side of one of the fingers (b-d).

In Figure 5.16, it has been shown that the wire is pulled by the finger tips without using the laser. This appears to be the easiest type of manipulation. The wire is moved using the inside of the fingers. Larger objects can be manipulated by pulling them, however, gripping can only be used for certain sizes of objects. The motion range of the fingers and the contact area of the finger tips puts a limit on the size of the objects to be gripper. Therefore, the microgripper should be replaced with a different size one, when objects with various dimensions need to be moved.

It has been realized that, for some objects lifting the object can be more convenient rather than gripping the object. The attempts to grip the electrical wire failed because of the small contact area of the microgripper finger tips. Another challenge was the adhesion of the gripper fingers with the gripped object. This was addressed by releasing the objects at an angle as suggested by [115]. It is also worth mentioning that when the size of the object is reduced, the adhesion
becomes more problematic. The adhesion is mainly caused by van der Waals and electrostatic forces [116]. Due to the scaling laws, weight of the object becomes negligible and the adhesion forces dominate as the gripped objects become smaller. Surface treatment of the gripper fingers for hydrophobic coating and making serrated finger tips can overcome the adhesion problem. The serrated finger tips will reduce the contact area between the gripped object as seen in Figure 5.17. In this work, the minimum feature size was 10 µm because of the resolution of the transparency mask. Chromium masks can be used to achieve the serrated structures which require higher lithography resolutions.

Finally, the levitation of the microgrippers was tested inside closed environments. The microrobot was placed inside a pyrex chamber as demonstrated in Figure 5.18. The top of the chamber was fully covered. The 3D trajectories discussed in Section 5.4 was applied and the same position recordings were observed. These experiments showed that the system is successful for operation in closed environments. It is worth mentioning that the chamber itself should not be conductor
for the magnetic field to penetrate inside it. In addition, for the current system, because the position measurements are performed using line-of-sight laser sensors, the chamber should be transparent. However, if another technique is used for position detection (see Section 6.2), the system can also be applied for manipulation in opaque chambers or closed channels, as well.
Figure 5.18: Levitation of the microrobot in a closed transparent chamber.
Chapter 6

Conclusions and Potential Future Work

6.1 Summary of Contributions

In this thesis, a magnetically levitated microgripper is presented for precise micro-manipulation tasks. The magnetic levitation setup is composed of a magnetic loop assembly that can adjust the magnetic flux density in a large air gap. Electromagnets are used to control the generated magnetic field. The position of the levitating object is continuously measured and the magnetic field is adjusted simultaneously. To determine the vertical position of the levitating object, the total amount of current applied to all electromagnets is changed. For horizontal position control, the current for each electromagnet is adjusted individually.

A microrobot is made that is composed of a polymer microgripper and magnetic samples. The magnetic portion of the robot interacts with the magnetic field formed by the levitation rig in order to generate the levitation force. The microgripper is used to pull, push, lift or grasp certain micro objects. Two versions of the microrobot is produced that vary depending on the material used for the magnetic section. Either electrodeposited Co-Ni-Mn-P magnetic thin films or commercial NdFeB permanent magnets are used.

One of the biggest challenges for the levitation of microrobot is the increasing effect of environment noise on the system. Air damping for the levitating object is almost negligible. It is seen that as the size of the levitating object is decreased,
the positioning precision decreases. This problem is addressed by eddy current damping. When a conductor plate is placed underneath the levitating objects, the eddy currents formed in the plate attenuates the vibration of the object. The eddy current damping effect is modeled and optimum plate dimensions are determined. The positioning accuracy was improved from 67.08 µm to 20.30 µm for a cylindrical NdFeB magnet with 2.5 mm height, 2.5 mm radius and 386 mg weight.

The levitating microrobot requires a dexterous tool for manipulation tasks. A microgripper is chosen to achieve pushing, pulling, lifting of objects as well as relatively complicated pick-and-place tasks. The microgripper uses bent-beam arms actuated photo-thermally. This allowed a single-mask fabrication without the tedious multi-mask fabrication steps. The microgrippers are made of SU-8 which is biocompatible and more easily deflected compared to metal and silicon. Thus, finger displacements of hundreds of micrometer are achieved with relatively low temperatures (200°C). The benefit of using lower temperature is the reduced risk of damaging of the gripped object. Four designs of microgrippers are fabricated and characterized in terms of finger deflection, gripper force, time response and repeatability. It is seen that all designs have high repeatability that is another important criterion for microgripper design. The gripping force is around 130 µN and time response is measured as approximately 1-2 seconds.

The microgripper designs that yield the maximum finger deflection are attached to mm-size permanent magnets to form the microrobot. The 3D positioning of the microrobot is demonstrated with an accuracy of 13.2 µm and 31 µm for vertical and horizontal position, respectively. The levitated microgripper is used for gripping of 125 µm diameter optical fiber and 1 mm diameter cable strip. In addition, pulling and lifting of 100 µm diameter electrical wire is also demonstrated.

The main contributions of the thesis are summarized below:

- Non-contact eddy current damping was modeled and implemented. This improved the positioning accuracy and decreased the positioning error to one third.

- Both in-plane and out-of-plane magnetized films were electrodeposited by modifying the bath concentration. This can lead to levitation of magnetic film coated devices in the desired orientation.
• Single-layer, biocompatible, low-cost microgrippers were fabricated. Photothermal actuation of polymeric structures was shown for the first time in the literature.

• The microgrippers were actuated in a non-contact manner which resolved problems associated with fabrication/integration of controller mechanism and power supply on the levitating device. Therefore, the microrobot can be minimized in parallel to the advancements in the microfabrication technology.

• Micromanipulation of micro objects was demonstrated for the first time for such a large air gap levitation system. Micrometer precision is obtained which is sufficient for positioning of 100 \( \mu \)m diameter objects.

• Operation in a closed chamber was also shown which may potentially lead to microsurgery or biomanipulation applications in human body with the implementation of a position detection technique that does not require line-of-sight.

This new technology presented in this dissertation offers unique features such as the elimination of moving components, dust-free operation, high motion range, flexible microrobot design. Using magnetic fields for positioning get around the problems of modeling complex surface forces. The driving power for the motion is generated by an external source, therefore the levitating robot itself does not have to carry any controller or power source, which makes further minimization possible. With the use of photo-thermal actuator, the microrobot can be fully controlled wirelessly and can be used in closed environments. Thus, the system foresees applications for in-vivo manipulation, microassembly and microsurgery.

6.2 Suggestions for Future Work

It can not be overemphasized that the system presented in this thesis is a novel technology platform which can be developed in many directions. Targeting for a very specific application can be the first step for the future modifications of the system. Considering the success of the system in micromanipulation, the system is not far away from being the upcoming technology in biomanipulation or microsurgery. The suggestions given in this section can guide the researchers and engineers for the
improvement of the system. Some references are also given which might be a good starting point. The suggestions are categorized under two titles: modifications on the current system and improvements by additional features.

6.2.1 Modifications on the current setup

- The quality of the deposited magnets can be improved to enhance the precision achieved by the electrodeposited thin films. Levitating microrobots with thin film coatings can be an ultimate solution if smaller robots are required. Although levitation was achieved using the electrodeposited magnets, these magnets still have much room for improvement. More extensive analysis can be performed on the magnetic properties of the films. If electrodeposition is used as a deposition technique, out-of-plane magnetization values can be improved by using non-monolithic deposited structures. In [58], it is shown that deposition of magnet arrays rather than a single layer film, greatly enhances the vertical magnetization values. The main reason for the enhancement is the use of shape anisotropy as a reinforcing force for the magnetization. Different methods of magnetic film production can be used as well. In a recent study of Floyd et al., laser micromachining of NdFeB magnets is presented for an untethered microrobot [117]. The use of rare earth magnets can greatly improve the magnetic properties as already shown in this thesis.

- Another improvement can be increasing the working range by replacing the laser displacement sensors. The currently available sensors limit the maximum working range and they require line-of-sight measurement. Therefore, the levitated object should always be optically traced. If the position of the levitating object can be measured electromagnetically or using heat radiation, the system can be used for in-vivo operations. NDI, a Waterloo based company, produces electromagnetic position sensors with a range of $50 \times 50 \times 50$ cm$^3$ (Aurora series) [118]. The high magnetic field required for levitation is a big challenge for any electromagnetic type position measurement. Therefore, radiative heat can be the first path to follow. In any case, the current laser sensors can be replaced with more advanced ones with higher resolution and higher operation range. This can be the easiest way to increase the precision and working range of the system.

- As a further improvement to increase the success of micromanipulation, the adhesion to the gripped object can be addressed. It is known that main sources of
adhesion are van der Waals and electrostatic forces. These forces vary depending on the materials, contact angles and surface properties. A detailed modeling of these forces can be done as in [116,119]. To reduce these adhesion forces, [115] suggests reducing the humidity of the environment and hydrophobic surface treatment of the microgripper fingers. Another possible solution can be modifying the tip of the gripping fingers as a serrated (saw-like) structure as already shown in Figure 5.17. This requires the use of a chromium mask with minimum feature sizes of a few micrometer. The transparency masks used in this thesis can only give a minimum feature size of 10 $\mu$m.

- During the experiments throughout this work, it has been seen that modifying the levitation setup for levitation of permanent magnets and electrodeposited magnets is a tedious tasks. The lasers should be uninstalled to safely remove the upper end of the yoke pole piece. Then, permanent magnets are assembled into that piece. To facilitate this time-consuming process, the mechanical assembly of the setup can be redesigned for easy modification of the setup for levitation of different objects.

- A portable version of the system can be developed with reduced air gap and reduced motion range. Such a version of the system can target more applications such as on-site characterization and point-of-care operations. If the specifications of the application can be well-defined, the mechanical assembly can be redesigned for portability. A detailed discussion of mechanical design of the setup is given by E. Shameli in [26]. Similar approaches used in [26] can be followed when redesigning the system.

- The downscaling of microrobots to micrometer-size might push the limits of the current controller. If the manipulated objects are on the same scale with the microrobot, then the controller should compensate for the extensive weight change during manipulation. In that case, an adaptive controller may be required for a robust controller approach.

### 6.2.2 Additional features

- An additional feature that can be of great use can be autonomous operation. The user interface can be modified to show the real-time image of the microrobot and its surrounding together with the system parameters. When a certain object around the microrobot is clicked by the user, the microrobot can automatically move
towards the object and grip it. In this case, extensive image processing should be done. Pattern recognition will be an important step for automation. Also, models should be developed for trajectory calculation and path following. Many studies can be found in the literature regarding pattern recognition, distance calculation and trajectory planning.

- The levitation system can be used to characterize adhesion forces for various surfaces. The microrobot can be levitated and get into contact with certain objects while monitoring the currents applied to the electromagnets and $x_{\text{ctrl}}$, $y_{\text{ctrl}}$ command inputs. When adhesion forces increase, the values of the command inputs should also increase to overcome the adhesion forces. This might allow modeling of very complex surface forces. Calibration of the levitation parameters is of paramount importance for this application. A haptic controller can be integrated with the system, to provide a more intuitive way of feedback to the operator. Also, the microrobot can be modified to carry some MEMS sensors for improved sensing.

- Another enhancement of the system can be the levitation of multiple robots. If multiple robots can be manipulated simultaneously, parallel manipulation can be possible. More advanced manipulation operations can be performed, which is very critical for a microsurgery application, for instance. To achieve the levitation of multiple robots, multiple $B_{\text{max}}$ points should be formed in the gap region. The assembly of the electromagnets and the pole piece should be modified for this purpose. The finite element simulations shown in this thesis will be of great help at this step.
Appendix A

Derivation of Eddy Current Damping Effect

In order to quantify the damping effect, flux penetrating the Al-disc should be determined. The magnetic flux has two components: \( \Phi_{em} \) and \( \Phi_{pm} \) that are the fluxes generated by the electromagnets and the permanent magnet, respectively. Although \( \Phi_{pm} \) can easily be calculated, calculation of \( \Phi_{em} \) is quite complicated because of the influence of the pole piece that connects the electromagnets. Therefore, oscillatory motion of the object is approximated by a sine function as illustrated in Figure A.1. For simplicity, flux penetrating the disc can be expressed as

\[
\Phi(t) = \Phi_{ref} - \Phi_1 \sin(2\pi ft),
\]

where \( \Phi_{ref} \) is the flux penetrating the disc when the magnet is at reference position and \( f \) is the frequency of oscillation. Therefore, the flux penetration when the magnet moves to the lower peak position becomes \( \Phi_{ref} + \Phi_1 \) (Figure A.1). Then \( \Phi_1 \) can be written as

\[
\Phi_1 = \Phi_{peak} - \Phi_{ref},
\]

where \( \Phi_{peak} \) is the flux penetration for the magnet’s lower peak position. The flux penetration through the plate due to the permanent magnet can easily be calculated when a circular plate is used. In spherical coordinates, magnetic flux density of the permanent magnet can be written as [120]

\[
B = \frac{\mu_0}{4\pi} m \left( \hat{r} \frac{2\cos\theta}{r^3} + \hat{\theta} \frac{\sin\theta}{r^3} \right),
\]
where \( m \) is the dipole moment of the magnet and \( \theta \) is the angle from the central axis. Flux passing through the plate is equal to the flux passing through the outer surface of the semi-sphere shown as dashed line in Figure A.1. Then penetrating flux can be found as

\[
\Phi_{pm} = \int B \cdot ds = \int_{sph} B \cdot \hat{r} ds = \int_0^{\cos^{-1}\frac{z'}{\sqrt{r^2 + z^2}}} \int_0^{2\pi} B_r r^2 \sin \theta d\phi d\theta = \frac{\mu_0}{2} m \frac{r^2}{(r^2 + z^2)^{3/2}},
\]

(A.4)

where \( z' \) is the object-disc distance and \( r \) is the radius of the disc.

Eq. (A.2) can be decomposed into components from the permanent magnet (pm) and the electromagnets (em)

\[
\Phi_1 = (\Phi_{pm,peak} + \Phi_{em,peak}) - (\Phi_{pm,ref} + \Phi_{em,ref}).
\]

(A.5)

Then, using Eq. (A.4), \( \Phi_{peak} \) and \( \Phi_{ref} \) takes the following form

\[
\Phi_{peak} = \frac{\mu_0}{2} m \left( \frac{r^2}{(r^2 + (z' - h)^2)^{3/2}} \right) + \Phi_{em,peak},
\]

(A.6)

\[
\Phi_{ref} = \frac{\mu_0}{2} m \left( \frac{r^2}{(r^2 + z^2)^{3/2}} \right) + \Phi_{em,ref}.
\]

(A.7)

Substituting Eqs. (A.6, A.7) into (A.5), the analytical expression for \( \Phi_1 \) can be obtained as

\[
\Phi_1 = \frac{\mu_0}{2} m \left[ \frac{r^2}{(r^2 + (z' - h)^2)^{3/2}} - \frac{r^2}{(r^2 + z^2)^{3/2}} \right] + \Delta \Phi_{em}.
\]

(A.8)
Obtaining an expression for $\Phi_1$ suffices to derive a damping coefficient since the $\Phi_{ref}$ component in Eq. (A.1) does not have a time dependency and does not contribute to the varying magnetic field.

Representing the conducting disc as $N$ turns of wire and using Eq. (A.1), the induced electromotive force in the conductor can be found as

$$V_{\text{ind}} = -N\frac{d\Phi}{dt} = N2\pi f\Phi_1 \cos(2\pi ft).$$

(A.9)

Then the average power dissipation in the conductor can be calculated as

$$P_{\text{avg}} = \frac{1}{T} \int_{t_0}^{t_0+T} \frac{V_{\text{ind}}^2}{R} dt = \frac{(N2\pi f\Phi_1)^2}{2R},$$

(A.10)

where $T = 1/f$ is the period of the motion and $R$ is the resistance of the path that eddy currents travel.

Denoting the force causing the vibrations as $F$ and assuming that the magnet moves with an average speed of $v$ during oscillations, the power dissipation can be written as

$$P_{\text{avg}} = Fv.$$  

(A.11)

The frequency of vibration is found as $f = v/(4h)$ using the maximum deflection during oscillation which is denoted as $h$ in (Figure A.1). Then Eq. (A.10) takes the form

$$P_{\text{avg}} = \frac{(N2\pi\Phi_1)^2}{2R} \left(\frac{v}{4h}\right)^2 = \frac{(N\pi\Phi_1v)^2}{8Rh^2}.$$  

(A.12)

Substituting Eq. (A.12) into (A.11) yields

$$F = \frac{(N\pi\Phi_1)^2}{8Rh^2}v.$$  

(A.13)

Using the relationship between the force and velocity, $F = cv$, it is now possible to write the damping coefficient as following

$$c = \frac{(N\pi\Phi_1)^2}{8Rh^2}.$$  

(A.14)

To investigate the optimum damping, this damping coefficient should be expressed as a function of plate parameters. For that purpose $N$ can be written as

$$N = \frac{dr}{a},$$  

(A.15)
where $d$ is the disc thickness, $r$ is the disc radius and $a$ is the cross-sectional area of the current pathway. The resistance of the path of current can be calculated by

$$R = \frac{l}{\sigma a}, \quad (A.16)$$

where $l = N2\pi \frac{r}{2} = N\pi r$. Substituting Eq. (A.16) into (A.14), the damping coefficient can be found as

$$c = \frac{d\pi\sigma\Phi_1^2}{8h^2}. \quad (A.17)$$

Eq. (A.17) indicates that damping introduced by the disc is proportional to the disc thickness and conductivity. However, it should be emphasized that eddy currents penetrate up to a certain depth from the surface of the disc, which is given by the penetration depth. Therefore, it is expected to observe a saturation of the damping, if the disc thickness is increased further than the standard penetration depth.

The other two parameters that affect the damping coefficient are the disc radius ($r$) and disc-object distance ($z'$) which are the variables that change $\Phi_1$ in Eq. (A.17). Intuitively, disc radius ($r$) should have a similar effect on damping as the disc thickness ($d$), i.e. increasing disc radius should increase the damping. However, when the disc is placed close to the magnet, a larger disc will cut through more returning flux (flux with a positive $\hat{z}$ component) and there will be a decrease in the net flux penetrating the disc, resulting in a smaller damping.

The relationship between the damping coefficient and the disc radius can be investigated by using Eq. (A.8). Figure A.2 illustrates the term in square brackets in Eq. (A.8), plotted for a certain deflection from the reference position ($h$). $\Delta\Phi_{em}$ is not included, since there is not an analytical expression for the magnetic field generated by the magnetic drive unit that consists of electromagnets, pole piece and a returning yoke. However; due to the effect of the returning yoke, electromagnets generate a uniform magnetic field in the motion range of interest. Therefore, $\Delta\Phi_{em}$ has a linear effect on the plot in Figure A.2, which would simply shift the curve up for increasing disc radius without affecting the observed behavior. The plot indicates that up to a certain limit, increasing disc radius increases the damping effect. Although further increase in radius increases the $\Delta\Phi_{em}$ term in Eq. (A.8), the change in damping will not be as significant because of the decrease observed in the plot. The critical radius for which damping is maximized (around 10 mm
Figure A.2: The effect of disc radius & disc-object distance on damping coefficient. $h = 0.2$ mm [28].

in Figure A.2), is a function of maximum deflection ($h$) and disc-object distance ($z'$). Therefore, to maximize the damping effect, damper dimensions and location should be set using Eq. (A.8).
Appendix B

Reference XRD Data
Table B.1: Best fit for the Ni-poor film
Cobalt - hexagonal, PDF# 05-0727

<table>
<thead>
<tr>
<th>$2\theta^\circ$</th>
<th>d (Å)</th>
<th>I (%)</th>
<th>(hk.l)</th>
</tr>
</thead>
<tbody>
<tr>
<td>41.68</td>
<td>2.165</td>
<td>20.0</td>
<td>10.0</td>
</tr>
<tr>
<td>44.76</td>
<td>2.023</td>
<td>60.0</td>
<td>00.2</td>
</tr>
<tr>
<td>47.57</td>
<td>1.910</td>
<td>100.0</td>
<td>10.1</td>
</tr>
<tr>
<td>62.73</td>
<td>1.480</td>
<td>1.0</td>
<td>10.2</td>
</tr>
<tr>
<td>75.94</td>
<td>1.252</td>
<td>80.0</td>
<td>11.0</td>
</tr>
<tr>
<td>84.20</td>
<td>1.149</td>
<td>80.0</td>
<td>10.3</td>
</tr>
<tr>
<td>90.62</td>
<td>1.084</td>
<td>20.0</td>
<td>20.0</td>
</tr>
<tr>
<td>92.54</td>
<td>1.066</td>
<td>80.0</td>
<td>11.2</td>
</tr>
<tr>
<td>94.73</td>
<td>1.047</td>
<td>60.0</td>
<td>20.1</td>
</tr>
<tr>
<td>98.73</td>
<td>1.015</td>
<td>20.0</td>
<td>00.4</td>
</tr>
</tbody>
</table>

Table B.2: Best fit for the Ni-rich film
Nickel - cubic, PDF# 65-2865

<table>
<thead>
<tr>
<th>$2\theta^\circ$</th>
<th>d (Å)</th>
<th>I (%)</th>
<th>(hkl)</th>
</tr>
</thead>
<tbody>
<tr>
<td>44.49</td>
<td>2.035</td>
<td>100.0</td>
<td>111</td>
</tr>
<tr>
<td>51.85</td>
<td>1.862</td>
<td>42.7</td>
<td>200</td>
</tr>
<tr>
<td>76.38</td>
<td>1.246</td>
<td>18.5</td>
<td>220</td>
</tr>
<tr>
<td>92.93</td>
<td>1.063</td>
<td>17.3</td>
<td>311</td>
</tr>
<tr>
<td>98.43</td>
<td>1.017</td>
<td>4.9</td>
<td>222</td>
</tr>
</tbody>
</table>
Appendix C

Matlab Script to Plot the Simulated Data

The following Matlab script is used to plot the 2D magnetic field data recorded at the postprocessing step of ANSYS simulations.

```matlab
[A B]=textread('PRPATH.lis', '%f %f ', 'headerlines', 1);
FF = zeros(17,17);
C = 0;

EN = -15;
for x=1:1:17
    ST = EN + 16;
    EN = ST + 16;
    if mod(x,2)==1
        V = B( ST:1: EN );
    end
    if mod(x,2)==0
        V = B( EN:-1: ST );
    end
    FF(:,x)=V;
end

figure
```
contour(FF,150)
grid
title('Horizontal 7EM z -80mm, Bmax=46 G')
ylabel('Distance (cm)')
xlabel('Distance (cm). Pole piece is where the title is')
set(gca,'XTick',1:2:17)
set(gca,'XTickLabel',{'-8','-6','-4','-2','0','2','4','6','8'})
set(gca,'YTick',1:2:17)
set(gca,'YTickLabel',{'-8','-6','-4','-2','0','2','4','6','8'})

FF = FF*10000; %Tesla to Gauss conversion
max(max(FF))
Appendix D

ANSYS Script for Finite Element Modeling of Microgrippers

The following script demonstrates the finite element model simulation of microgripper d-II.

1. The material constants and geometrical parameters are defined. MicroMKS units are used.

*SET,pi,22/7
*SET,d_su8,1200e-18
*SET,E_su8,4e3
*SET,PR_su8,0.22
*SET,TCE_su8,52e-6
*SET,k_su8,0.2e6
*SET,c_su8,1500e12

*SET,L1,400
*SET,L2,350
*SET,d0,20
*SET,d1,70
*SET,d2,60
*SET,w1,20
*SET,w2,23
*SET, w3, 27
*SET, theta1, 6*pi/180
*SET, theta2, 45*pi/180
*SET, thickness, 50
*SET, radius, 75
*SET, spot, 60

*SET, laser_heat, 500e-6*1e12
*SET, heat_flux, laser_heat/pi/spot/spot
*SET, force_tip, 3/2  !applied at two nodes
*SET, filmCoeff, 10

2. The 3D model of the microgripper is drawn.

*SET, x_1, 0
*SET, y_1, L1*sin(theta1)
*SET, x_2, 0
*SET, y_2, y_1+w1/cos(theta1)
*SET, x_4, L1*cos(theta1)
*SET, y_4, 0
*SET, x_3, x_4
*SET, y_3, w1/cos(theta1)
*SET, x_5, 0
*SET, y_5, y_2+d1
*SET, x_6, w2/sin(theta2)
*SET, y_6, y_5
*SET, x_8, L2*cos(theta2)
*SET, y_8, y_5+L2*sin(theta2)
*SET, x_7, x_8+w2/sin(theta2)-10
*SET, y_7, y_8-10
*SET, x_12, x_4+d2
*SET, y_12, 0
*SET, theta3, atan(y_8/(x_12-x_8))
*SET, x_11, x_12+w3/sin(theta3)
*SET, y_11, 0
*SET,x_9,d0/2
*SET,y_9,y_8+tan(theta3)*(x_8-d0/2)
*SET,x_10,x_9
*SET,y_10,y_9+w3/cos(theta3)

/PREP7

K,1,x_1,y_1,0
K,2,x_2,y_2,0
K,3,x_3,y_3,0
K,4,x_4,y_4,0
A,1,2,3,4

K,5,x_5,y_5,0
K,6,x_6,y_6,0
K,7,x_7,y_7,0
K,8,x_8,y_8,0
A,5,6,7,8

K,9,x_9,y_9,0
K,10,x_10,y_10,0
K,11,x_11,y_11,0
K,12,x_12,y_12,0
A,9,10,11,12

ARSYM,x,ALL,,,,0,0
CYL4,0,y_2+d1/2,radius

AADD,ALL
NUMCMP,AREA
VOFFST,1,thickness, !extrudes to minus z direction.

ALLSEL,ALL
3. Material properties are defined for the photo-thermal analysis.

\[
\text{ET,1,SOLID90}
\]

\[
\text{MP,KXX,1,k\_su8} \quad \text{! thermal conductivity}
\]

\[
\text{MP,DENS,1,d\_su8} \quad \text{! density}
\]

\[
\text{MP,C,1,c\_su8} \quad \text{! specific heat}
\]

\[
\text{VSEL,ALL VATT,1,,,} \quad \text{! makes all volumes SU-8}
\]

4. Meshing is done using smart-meshing feature.

\[
\text{SMRT,6}
\]

\[
\text{MSHAPE,1,3D}
\]

\[
\text{MSHKEY,0}
\]

\[
\text{VSEL,ALL}
\]

\[
\text{VMESH,ALL}
\]

\[
\text{ALLSEL,ALL}
\]

5. Boundary conditions are defined as fixed temperature at base connection surfaces of the arms. Also heat flux is applied on the circular region to simulate the focused laser beam. Convection losses are defined for the outer surfaces.

\[
\text{ASEL,S,,,15,,,} \quad \text{! thick arm1}
\]

\[
\text{ASEL,A,,,9,,,} \quad \text{! thin arm1}
\]

\[
\text{ASEL,A,,,4,,,} \quad \text{! thin arm2}
\]

\[
\text{ASEL,A,,,26,,,} \quad \text{! thick arm2}
\]

\[
\text{NSLA,S,1 D,ALL, ,300, , ,TEMP, , , ,} \quad \text{! fixed temperature}
\]

\[
\text{SFA,32,,HFLUX,heat\_flux} \quad \text{! heat flux is applied}
\]

\[
\text{NSEL,ALL}
\]
TUNIF,300
ALLSEL, ALL

ASEL,ALL
NSLA,S,1
SF,ALL,CONV,filmCoeff,300 ! convection loss is defined.

! The temperature environment is saved
PHYSICS,WRITE,thermal
PHYSICS,CLEAR

6. Material properties are defined for the thermo-mechanical analysis.

ET,1,SOLID95

MP,EX,1,E_su8 ! Young’s modulus
MP,PRXY,1,PR_su8 ! Poisson’s ratio
MP,ALPX,1,TCE_su8 ! Coef. thermal expansion
MP,DENS,1,d_su8 ! Density

7. Boundary conditions are defined as fixed arm connections to the base.

ASEL,S,,,15,,, ! thick arm1
ASEL,A,,,9,,, ! thin arm1
ASEL,A,,,4,,, ! thin arm2
ASEL,A,,,26,,, ! thick arm2
NSLA,S,1 D,ALL,,0,,UX,UY,UZ,,
ALLSEL,ALL
TREF,300 ! reference temperature for alpha*(T-TREF).

! The structural environment is saved
PHYSICS,WRITE,struct
SAVE
FINISH
8. The solution is done in two steps. First the temperature distribution is determined, then the results of the temperature analysis is used to calculate elongations and deformed structure.

/SOL
PHYSICS,READ,thermal
SOLVE
FINISH

/SOL
PHYSICS,READ,struct
LDREAD,TEMP,,,,,,RTH
SOLVE
FINISH

9. The deformations, temperature distribution and von Mises stress are plotted as post-processing.

/POST1
/EFACET,1

PLNSOL, U,X, 2,1.0 ! Plots Ux displacement
PLNSOL, U,Z, 2,1.0 ! Plots Uz displacement
PLNSOL, BFE,TEMP, 0,1.0 ! Plots temperature distribution
PLNSOL, S,EQV, 2,1.0 ! Plots von Mises stress
Appendix E

The Transparency Mask Used for d-II Type Microgrippers

The following mask shows the pdf-print of the transparency mask used for fabrication of d-II type of microgrippers. It can be seen that the microgrippers are positioned row-wise. In a single batch, hundreds of microgrippers can be fabricated on a single wafer. The geometrical parameters are different for the microgrippers to test their affect on finger deflection. The size of the microgripper to be levitated is determined by the size of the objects to be manipulated.
Figure E.1: Sample transparency mask. Scaled to the page limits.
Appendix F

FEMLAB Simulations of Magnetic Field of Microrobots

The following figures show the magnetic flux density generated by microrobot configurations given in Figure 5.6. Out-of-plane and in-plane magnetized NdFeB magnets were used when configuring these robots. The magnetization value for NdFeB was taken as $10^6$ A/m. The simulations show the 3D magnetic field distribution using the arrows and the magnetic flux density on the plane that crosses the microrobot.
Figure F.1: Magnetic flux density generated by the microrobot shown in Figure 5.6(a): (a) 3D magnetic flux density, (b) Magnetic flux density on a plane.
Figure F.2: Magnetic flux density generated by the microrobot shown in Figure 5.6(c): (a) 3D magnetic flux density, (b) Magnetic flux density on a plane.
Figure F.3: Magnetic flux density generated by the microrobot shown in Figure 5.6(e): (a) 3D magnetic flux density, (b) Magnetic flux density on a plane.
Appendix G

List of Publications

G.1  Journal Articles


G.2  Conference Papers


G.3 Submitted Journal and Conference Papers


4. C. Elbuken M. B. Khamessie and M. Yavuz "Magnetic Levitation as a Micromanipulation Technique for MEMS," 53rd annual conf. on magnetism and magnetic materials, MMM'08, Austin, TX, (submission ID: 525124).
References


